

TLE202x-Q1, TLE202xA-Q1
EXCALIBUR HIGH-SPEED LOW-POWER PRECISION
OPERATIONAL AMPLIFIERS

SGLS199B – JANUARY 2004 – REVISED APRIL 2008

- Qualified for Automotive Applications
- ESD Protection Exceeds 1000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Supply Current . . . 300 μ A Max
- High Unity-Gain Bandwidth . . . 2 MHz Typ
- High Slew Rate . . . 0.45 V/ μ s Min
- Supply-Current Change Over Full Temp Range . . . 10 μ A Typ at $V_{CC} \pm = \pm 15$ V
- Specified for Both 5-V Single-Supply and ± 15 -V Operation
- Phase-Reversal Protection
- High Open-Loop Gain . . . 6.5 V/ μ V (136 dB) Typ
- Low Offset Voltage . . . 100 μ V Max
- Offset Voltage Drift With Time 0.005 μ V/mo Typ
- Low Input Bias Current . . . 50 nA Max
- Low Noise Voltage . . . 19 nV/ $\sqrt{\text{Hz}}$ Typ

description

The TLE202x and TLE202xA devices are precision, high-speed, low-power operational amplifiers using a new Texas Instruments Excalibur process. These devices combine the best features of the OP21 with highly improved slew rate and unity-gain bandwidth.

The complementary bipolar Excalibur process utilizes isolated vertical pnp transistors that yield dramatic improvement in unity-gain bandwidth and slew rate over similar devices.

The addition of a bias circuit in conjunction with this process results in extremely stable parameters with both time and temperature. This means that a precision device remains a precision device even with changes in temperature and over years of use.

This combination of excellent dc performance with a common-mode input voltage range that includes the negative rail makes these devices the ideal choice for low-level signal conditioning applications in either single-supply or split-supply configurations. In addition, these devices offer phase-reversal protection circuitry that eliminates an unexpected change in output states when one of the inputs goes below the negative supply rail.

A variety of available options includes small-outline versions for high-density systems applications.

The Q-suffix devices are characterized for operation over the full automotive temperature range of -40°C to 125°C .



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date.
Products conform to specifications per the terms of Texas Instruments
standard warranty. Production processing does not necessarily include
testing of all parameters.

Copyright © 2008, Texas Instruments Incorporated



www.BDTI.com/TI

**TLE202x-Q1, TLE202xA-Q1
EXCALIBUR HIGH-SPEED LOW-POWER PRECISION
OPERATIONAL AMPLIFIERS**

SGLS199B – JANUARY 2004 – REVISED APRIL 2008

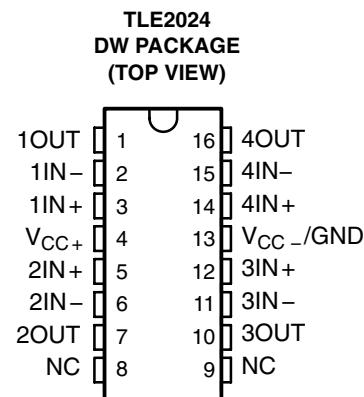
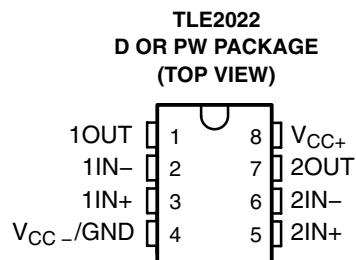
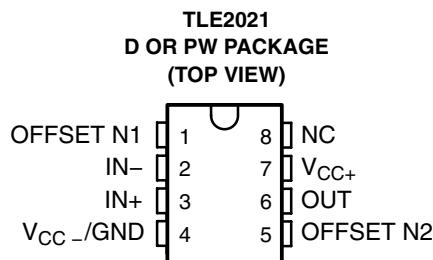
ORDERING INFORMATION[†]

T _A	V _{IOMAX} AT 25°C	PACKAGE [‡]		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 125°C	200 µV	SOIC (D)	Tape and reel	TLE2021AQDRQ1	2021AQ
		TSSOP (PW)	Tape and reel	TLE2021AQPWRQ1§	2021AQ
	500 µV	SOIC (D)	Tape and reel	TLE2021QDRQ1	2021Q1
		TSSOP (PW)	Tape and reel	TLE2021QPWRQ1§	2021Q1
–40°C to 125°C	300 µV	SOIC (D)	Tape and reel	TLE2022AQDRQ1	2021AQ
		TSSOP (PW)	Tape and reel	TLE2022AQPWRQ1§	2022AQ1
	500 µV	SOIC (D)	Tape and reel	TLE2022QDRQ1	2022Q1
		TSSOP (PW)	Tape and reel	TLE2022QPWRQ1§	2022Q1
–40°C to 125°C	750 µV	SOP (DW)	Tape and reel	TLE2024AQDWRQ1	2024AQ1
	1000 µV	SOP (DW)	Tape and reel	TLE2024QDWRQ1	2024Q1

[†] For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at <http://www.ti.com>.

[‡] Package drawings, thermal data, and symbolization are available at <http://www.ti.com/packaging>.

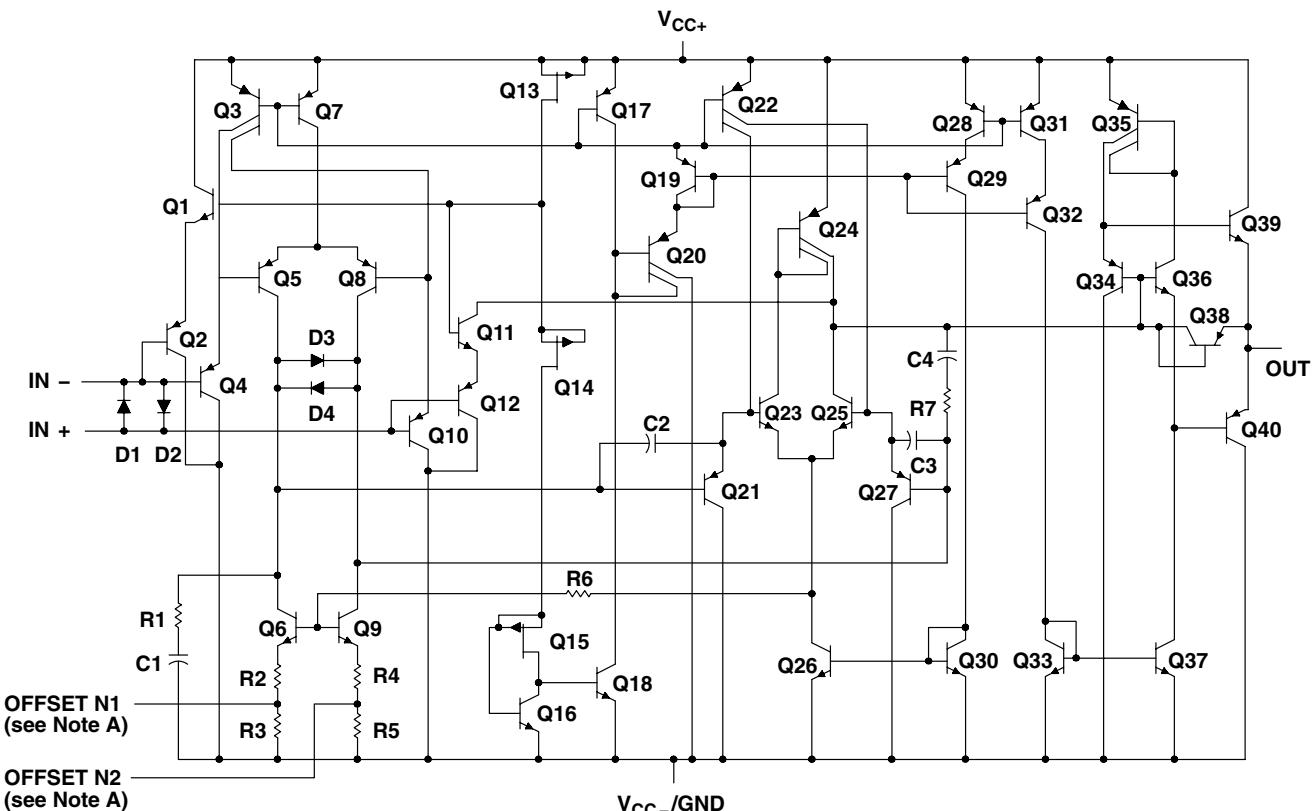
§ Product preview



NC – No internal connection

TLE202x-Q1, TLE202xA-Q1
**EXCALIBUR HIGH-SPEED LOW-POWER PRECISION
 OPERATIONAL AMPLIFIERS**
 SGLS199B – JANUARY 2004 – REVISED APRIL 2008

equivalent schematic (each amplifier)



ACTUAL DEVICE COMPONENT COUNT			
COMPONENT	TLE2021	TLE2022	TLE2024
Transistors	40	80	160
Resistors	7	14	28
Diodes	4	8	16
Capacitors	4	8	16

TLE202x-Q1, TLE202xA-Q1 EXCALIBUR HIGH-SPEED LOW-POWER PRECISION OPERATIONAL AMPLIFIERS

SGLS199B – JANUARY 2004 – REVISED APRIL 2008

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)^t

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES:

1. All voltage values, except differential voltages, are with respect to the midpoint between V_{CC+} , and V_{CC-} .
2. Differential voltages are at IN+ with respect to IN-. Excessive current flows if a differential input voltage in excess of approximately ± 600 mV is applied between the inputs unless some limiting resistance is used.
3. The output may be shorted to either supply. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded.
4. Maximum power dissipation is a function of $T_J(\text{max})$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(\text{max}) - T_A)/\theta_{JA}$. Selecting the maximum of 150°C can affect reliability.
5. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

		MIN	MAX	UNIT
Supply voltage, V_{CC}		± 2	± 20	V
Common-mode input voltage, V_{IC}	$V_{CC} = \pm 5\text{ V}$	0	3.2	V
	$V_{CC\pm} = \pm 15\text{ V}$	-15	13.2	
Operating free-air temperature, T_A		-40	125	°C

TLE202x-Q1, TLE202xA-Q1
EXCALIBUR HIGH-SPEED LOW-POWER PRECISION
OPERATIONAL AMPLIFIERS

SGLS199B – JANUARY 2004 – REVISED APRIL 2008

TLE2021 electrical characteristics at specified free-air temperature, $V_{CC} = 5\text{ V}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T_A^\dagger	TLE2021-Q1			TLE2021A-Q1			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
V_{IO}	$V_{IC} = 0, R_S = 50\Omega$	25°C	120	600	600	100	400	400	μV
		Full range		800			550		
		Full range		2			2		$\mu\text{V}/^\circ\text{C}$
		25°C	0.005			0.005			$\mu\text{V}/\text{mo}$
		25°C	0.2	6	6	0.2	6	6	nA
		Full range		10			10		
I_{IO}		25°C	25	70	70	25	70	70	nA
		Full range		90			90		
V_{ICR}	$R_S = 50\Omega$	25°C	0 to 3.5	-0.3 to 4	0 to 3.5	-0.3 to 4	0 to 3.5	-0.3 to 4	V
		Full range	0 to 3.2		0 to 3.2	0 to 3.2	0 to 3.2		
		25°C	4	4.3	4	4.3	4	4.3	V
		Full range	3.8		3.8	3.8			
V_{OL}	$R_L = 10\text{ k}\Omega$	25°C	0.7	0.8	0.8	0.7	0.8	0.8	V
		Full range		0.95			0.95		
A_{VD}	$V_O = 1.4\text{ V to }4\text{ V}, R_L = 10\text{ k}\Omega$	25°C	0.3	1.5	1.5	0.3	1.5	1.5	$\text{V}/\mu\text{V}$
		Full range	0.1			0.1			
$CMRR$	$V_{IC} = V_{ICR\min}, R_S = 50\Omega$	25°C	85	110	110	85	110	110	dB
		Full range	80			80			
k_{SVR}	$V_{CC} = 5\text{ V to }30\text{ V}$	25°C	105	120	120	105	120	120	dB
		Full range	100			100			
I_{CC}	$V_O = 2.5\text{ V}, \text{No load}$	25°C	170	300	300	170	300	300	μA
		Full range		300			300		
ΔI_{CC}		Full range		9			9		μA

[†] Full range is -40°C to 125°C .

NOTE 4: Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at $T_A = 150^\circ\text{C}$ extrapolated to $T_A = 25^\circ\text{C}$ using the Arrhenius equation and assuming an activation energy of 0.96 eV.

**TLE202x-Q1, TLE202xA-Q1
EXCALIBUR HIGH-SPEED LOW-POWER PRECISION
OPERATIONAL AMPLIFIERS**

SGLS199B – JANUARY 2004 – REVISED APRIL 2008

TLE2021 electrical characteristics at specified free-air temperature, $V_{CC} = \pm 15$ V (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T_A^\dagger	TLE2021-Q1			TLE2021A-Q1			UNIT	
			MIN	TYP	MAX	MIN	TYP	MAX		
V_{IO} Input offset voltage	$V_{IC} = 0$, $R_S = 50\Omega$	25°C	120	500		80	300		μV	
		Full range		700			450			
		Full range		2		2			$\mu V/^\circ C$	
		25°C	0.006			0.006			$\mu V/mo$	
		25°C	0.2	6		0.2	6		nA	
I_{IO} Input offset current		Full range		10			10			
		25°C	25	70		25	70		nA	
		Full range		90			90			
		25°C	-15 to 13.5	-15.3 to 14		-15 to 13.5	-15.3 to 14		V	
V_{ICR} Common-mode input voltage range	$R_S = 50\Omega$	Full range	-15 to 13.2			-15 to 13.2				
		25°C	14	14.3		14	14.3		V	
		Full range	13.8			13.8				
		25°C	-13.7	-14.1		-13.7	-14.1		V	
		Full range	-13.6			-13.6				
A_{VD} Large-signal differential voltage amplification	$V_O = \pm 10$ V, $R_L = 10\text{ k}\Omega$	25°C	1	6.5		1	6.5		$V/\mu V$	
		Full range	0.5			0.5				
		25°C	100	115		100	115		dB	
$CMRR$ Common-mode rejection ratio	$V_{IC} = V_{ICR\min}$, $R_S = 50\Omega$	Full range	96			96				
		25°C	105	120		105	120		dB	
		Full range	100			100				
k_{SVR} Supply-voltage rejection ratio ($\Delta V_{CC\pm}/\Delta V_{IO}$)	$V_{CC\pm} = \pm 2.5$ V to ± 15 V	25°C	200	350		200	350		μA	
		Full range		350			350			
		Full range		10			10		μA	
I_{CC} Supply current	$V_O = 0$,	25°C	200	350		200	350		μA	
		Full range		350			350			
ΔI_{CC} Supply current change over operating temperature range	No load	Full range							μA	

[†] Full range is $-40^\circ C$ to $125^\circ C$.

NOTE 4: Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at $T_A = 150^\circ C$ extrapolated to $T_A = 25^\circ C$ using the Arrhenius equation and assuming an activation energy of 0.96 eV.

TLE202x-Q1, TLE202xA-Q1
EXCALIBUR HIGH-SPEED LOW-POWER PRECISION
OPERATIONAL AMPLIFIERS

SGS199B – JANUARY 2004 – REVISED APRIL 2008

TLE2022 electrical characteristics at specified free-air temperature, $V_{CC} = 5\text{ V}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T_A^\dagger	TLE2022-Q1			TLE2022A-Q1			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
V_{IO}	$V_{IC} = 0, R_S = 50\Omega$	25°C	600		400				μV
		Full range	800		550				
		Full range	2		2				$\mu\text{V}/^\circ\text{C}$
		25°C	0.005		0.005				$\mu\text{V}/\text{mo}$
		25°C	0.5	6		0.4	6		nA
		Full range		10			10		
		25°C	35	70		33	70		nA
		Full range		90			90		
V_{ICR}	$R_S = 50\Omega$	25°C	0 to 3.5	-0.3 to 4		0 to 3.5	-0.3 to 4		V
		Full range	0 to 3.2		0 to 3.2				
		25°C	4	4.3		4	4.3		V
		Full range	3.8		3.8				
V_{OL}	$R_L = 10\text{ k}\Omega$	25°C	0.7	0.8		0.7	0.8		V
		Full range		0.95			0.95		
A_{VD}	$V_O = 1.4\text{ V to }4\text{ V}, R_L = 10\text{ k}\Omega$	25°C	0.3	1.5		0.4	1.5		$\text{V}/\mu\text{V}$
		Full range	0.1		0.1				
CMRR	$V_{IC} = V_{ICR\min}, R_S = 50\Omega$	25°C	85	100		87	102		dB
		Full range	80		82				
k_{SVR}	$V_{CC} = 5\text{ V to }30\text{ V}$	25°C	100	115		103	118		dB
		Full range	95		98				
I_{CC}	$V_O = 2.5\text{ V}, \text{No load}$	25°C	450	600		450	600		μA
		Full range		600			600		
ΔI_{CC}		Full range		37			37		μA

[†] Full range is -40°C to 125°C .

NOTE 4: Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at $T_A = 150^\circ\text{C}$ extrapolated to $T_A = 25^\circ\text{C}$ using the Arrhenius equation and assuming an activation energy of 0.96 eV.

**TLE202x-Q1, TLE202xA-Q1
EXCALIBUR HIGH-SPEED LOW-POWER PRECISION
OPERATIONAL AMPLIFIERS**

SGLS199B – JANUARY 2004 – REVISED APRIL 2008

TLE2022 electrical characteristics at specified free-air temperature, $V_{CC} = \pm 15$ V (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T_A^\dagger	TLE2022-Q1			TLE2022A-Q1			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
V_{IO}	$V_{IC} = 0$, $R_S = 50\Omega$	25°C	150	500		120	300		μV
		Full range		700			450		
		Full range		2			2		$\mu V/^\circ C$
		25°C	0.006			0.006			$\mu V/mo$
		25°C	0.5	6		0.4	6		nA
		Full range		10			10		
I_{IO}		25°C	35	70		33	70		nA
		Full range		90			90		
V_{ICR}	$R_S = 50\Omega$	25°C	-15 to 13.5	-15.3 to 14		-15 to 13.5	-15.3 to 14		V
		Full range	-15 to 13.2			-15 to 13.2			
		25°C	14	14.3		14	14.3		V
		Full range	13.8			13.8			
V_{OM+}	$R_L = 10\text{ k}\Omega$	25°C	-13.7	-14.1		-13.7	-14.1		V
		Full range	-13.6			-13.6			
A_{VD}	$V_O = \pm 10\text{ V}$, $R_L = 10\text{ k}\Omega$	25°C	0.8	4		1	7		$V/\mu V$
		Full range	0.8			1			
$CMRR$	$V_{IC} = V_{ICR\min}$, $R_S = 50\Omega$	25°C	95	106		97	109		dB
		Full range	91			93			
k_{SVR}	$V_{CC\pm} = \pm 2.5\text{ V}$ to $\pm 15\text{ V}$	25°C	100	115		103	118		dB
		Full range	95			98			
I_{CC}	$V_O = 0$, No load	25°C	550	700		550	700		μA
		Full range		700			700		
ΔI_{CC}		Full range		60			60		μA

[†] Full range is $-40^\circ C$ to $125^\circ C$.

NOTE 4: Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at $T_A = 150^\circ C$ extrapolated to $T_A = 25^\circ C$ using the Arrhenius equation and assuming an activation energy of 0.96 eV.

TLE202x-Q1, TLE202xA-Q1
EXCALIBUR HIGH-SPEED LOW-POWER PRECISION
OPERATIONAL AMPLIFIERS

SGS199B – JANUARY 2004 – REVISED APRIL 2008

TLE2024 electrical characteristics at specified free-air temperature, $V_{CC} = 5$ V (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T_A^\dagger	TLE2024-Q1			TLE2024A-Q1			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
V_{IO} Input offset voltage	$V_{IC} = 0$, $R_S = 50\ \Omega$	25°C	1100			850			μV
		Full range	1300			1050			
		Full range	2			2			$\mu\text{V}/^\circ\text{C}$
		25°C	0.005			0.005			$\mu\text{V}/\text{mo}$
I_{IO} Input offset current	$R_L = 10\ \text{k}\Omega$	25°C	0.6	6		0.5	6		nA
		Full range	10			10			
		25°C	45	70		40	70		nA
		Full range	90			90			
V_{ICR} Common-mode input voltage range	$R_S = 50\ \Omega$	25°C	0	-0.3		0	-0.3		V
			to	to		to	to		
			3.5	4		3.5	4		
		Full range	0			0			
V_{OH} High-level output voltage	$V_O = 1.4\ \text{V to } 4\ \text{V},\ R_L = 10\ \text{k}\Omega$	25°C	3.9	4.2		3.9	4.2		V
		Full range	3.7			3.7			
		25°C	0.7	0.8		0.7	0.8		V
		Full range	0.95			0.95			
A_{VD} Large-signal differential voltage amplification	$V_{IC} = V_{ICR\min},\ R_S = 50\ \Omega$	25°C	0.2	1.5		0.3	1.5		$\text{V}/\mu\text{V}$
		Full range	0.1			0.1			
CMRR Common-mode rejection ratio	$V_{CC\pm} = \pm 2.5\ \text{V to } \pm 15\ \text{V}$	25°C	80	90		82	92		dB
		Full range	80			82			
k_{SVR} Supply-voltage rejection ratio ($\Delta V_{CC\pm}/\Delta V_{IO}$)	$V_O = 0$, No load	25°C	98	112		100	115		dB
		Full range	93			95			
I_{CC} Supply current	$V_O = 0$, No load	25°C	800	1200		800	1200		μA
		Full range	1200			1200			
ΔI_{CC} Supply current change over operating temperature range		Full range	50			50			μA

[†] Full range is -40°C to 125°C.

NOTE 4: Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at $T_A = 150^\circ\text{C}$ extrapolated to $T_A = 25^\circ\text{C}$ using the Arrhenius equation and assuming an activation energy of 0.96 eV.

**TLE202x-Q1, TLE202xA-Q1
EXCALIBUR HIGH-SPEED LOW-POWER PRECISION
OPERATIONAL AMPLIFIERS**

SGLS199B – JANUARY 2004 – REVISED APRIL 2008

TLE2024 electrical characteristics at specified free-air temperature, $V_{CC} = \pm 15$ V (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T_A^\dagger	TLE2024-Q1			TLE2024A-Q1			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
V_{IO}	$V_{IC} = 0$, $R_S = 50\Omega$	25°C	1000			750			μV
α_{VIO}		Full range		1200			950		
		Full range		2		2			
Input offset voltage long-term drift (see Note 4)		25°C	0.006			0.006			$\mu V/\text{mo}$
I_{IO}		25°C	0.6	6		0.2	6		nA
		Full range		10			10		
I_{IB}	$V_{IC} = V_{ICR\min}$, $R_S = 50\Omega$	25°C	50	70		45	70		nA
		Full range		90			90		
V_{ICR}		25°C	-15	-15.3		-15	-15.3		V
Common-mode input voltage range			to	to		to	to		
			13.5	14		13.5	14		
		Full range	-15			-15			
			to			to			
			13.2			13.2			
V_{OM+}	$R_L = 10\text{k}\Omega$	25°C	13.8	14.1		13.8	14.2		V
Maximum positive peak output voltage swing		Full range	13.7			13.7			
V_{OM-}		25°C	-13.7	-14.1		-13.7	-14.1		V
Maximum negative peak output voltage swing		Full range	-13.6			-13.6			
A_{VD}	$V_O = \pm 10\text{ V}$, $R_L = 10\text{k}\Omega$	25°C	0.4	2		0.8	4		$V/\mu V$
Large-signal differential voltage amplification		Full range	0.4			0.8			
$CMRR$	$V_{IC} = V_{ICR\min}$, $R_S = 50\Omega$	25°C	92	102		94	105		dB
Common-mode rejection ratio		Full range	88			90			
k_{SVR}	$V_{CC\pm} = \pm 2.5\text{ V}$ to $\pm 15\text{ V}$	25°C	98	112		100	115		dB
Supply-voltage rejection ratio ($\Delta V_{CC\pm}/\Delta V_{IO}$)		Full range	93			95			
I_{CC}	$V_O = 0$, No load	25°C	1050	1400		1050	1400		μA
Supply current		Full range		1400			1400		
ΔI_{CC}		Full range		85		85			μA

[†] Full range is -40°C to 125°C.

NOTE 4: Typical values are based on the input offset voltage shift observed through 168 hours of operating life test at $T_A = 150^\circ\text{C}$ extrapolated to $T_A = 25^\circ\text{C}$ using the Arrhenius equation and assuming an activation energy of 0.96 eV.

TLE202x-Q1, TLE202xA-Q1
EXCALIBUR HIGH-SPEED LOW-POWER PRECISION
OPERATIONAL AMPLIFIERS

SGS199B – JANUARY 2004 – REVISED APRIL 2008

TLE2021 operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	T_A	MIN	TYP	MAX	UNIT
SR Slew rate at unity gain	$V_O = 1 \text{ V}$ to 3 V , See Figure 1	25°C		0.5		$\text{V}/\mu\text{s}$
V_n Equivalent input noise voltage (see Figure 2)	$f = 10 \text{ Hz}$	25°C		21		nV/Hz
	$f = 1 \text{ kHz}$	25°C		17		
$V_{N(PP)}$ Peak-to-peak equivalent input noise voltage	$f = 0.1$ to 1 Hz	25°C		0.16		μV
	$f = 0.1$ to 10 Hz	25°C		0.47		
I_n Equivalent input noise current		25°C		0.9		pA/Hz
B_1 Unity-gain bandwidth	See Figure 3	25°C		1.2		MHz
ϕ_m Phase margin at unity gain	See Figure 3	25°C		42°		

TLE2021 operating characteristics at specified free-air temperature, $V_{CC} = \pm 15 \text{ V}$

PARAMETER	TEST CONDITIONS	T_A^\dagger	MIN	TYP	MAX	UNIT
SR Slew rate at unity gain	$V_O = \pm 10 \text{ V}$, See Figure 1	25°C	0.45	0.65		$\text{V}/\mu\text{s}$
		Full range		0.4		
V_n Equivalent input noise voltage (see Figure 2)	$f = 10 \text{ Hz}$	25°C		19		nV/Hz
	$f = 1 \text{ kHz}$	25°C		15		
$V_{N(PP)}$ Peak-to-peak equivalent input noise voltage	$f = 0.1$ to 1 Hz	25°C		0.16		μV
	$f = 0.1$ to 10 Hz	25°C		0.47		
I_n Equivalent input noise current		25°C		0.09		pA/Hz
B_1 Unity-gain bandwidth	See Figure 3	25°C		2		MHz
ϕ_m Phase margin at unity gain	See Figure 3	25°C		46°		

† Full range is -40°C to 125°C for the Q-suffix devices.

TLE2022 operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
SR Slew rate at unity gain	$V_O = 1 \text{ V}$ to 3 V , See Figure 1		0.5		$\text{V}/\mu\text{s}$
V_n Equivalent input noise voltage (see Figure 2)	$f = 10 \text{ Hz}$		21		nV/Hz
	$f = 1 \text{ kHz}$		17		
$V_{N(PP)}$ Peak-to-peak equivalent input noise voltage	$f = 0.1$ to 1 Hz		0.16		μV
	$f = 0.1$ to 10 Hz		0.47		
I_n Equivalent input noise current			0.1		$\text{pA}/\sqrt{\text{Hz}}$
B_1 Unity-gain bandwidth	See Figure 3		1.7		MHz
ϕ_m Phase margin at unity gain	See Figure 3		47°		

**TLE202x-Q1, TLE202xA-Q1
EXCALIBUR HIGH-SPEED LOW-POWER PRECISION
OPERATIONAL AMPLIFIERS**

SGLS199B – JANUARY 2004 – REVISED APRIL 2008

TLE2022 operating characteristics at specified free-air temperature, $V_{CC} = \pm 15$ V

PARAMETER	TEST CONDITIONS	T_A^\dagger	MIN	TYP	MAX	UNIT
SR Slew rate at unity gain	$V_O = \pm 10$ V, See Figure 1	25°C	0.45	0.65		V/ μ s
		Full range	0.4			
V_n Equivalent input noise voltage (see Figure 2)	f = 10 Hz	25°C	19			nV/ $\sqrt{\text{Hz}}$
	f = 1 kHz	25°C	15			
$V_{N(PP)}$ Peak-to-peak equivalent input noise voltage	f = 0.1 to 1 Hz	25°C	0.16			μ V
	f = 0.1 to 10 Hz	25°C	0.47			
I_n Equivalent input noise current		25°C	0.1			pA/ $\sqrt{\text{Hz}}$
B_1 Unity-gain bandwidth	See Figure 3	25°C	2.8			MHz
ϕ_m Phase margin at unity gain	See Figure 3	25°C	52°			

† Full range is -40°C to 125°C.

TLE2024 operating characteristics, $V_{CC} = 5$ V, $T_A = 25$ °C

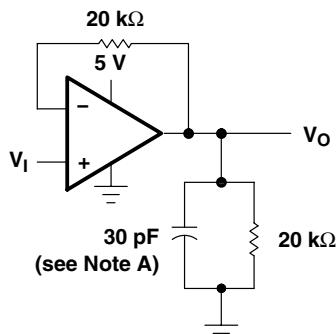
PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
SR Slew rate at unity gain	$V_O = 1$ V to 3 V, See Figure 1	0.5			V/ μ s
V_n Equivalent input noise voltage (see Figure 2)	f = 10 Hz	21			nV/ $\sqrt{\text{Hz}}$
	f = 1 kHz	17			
$V_{N(PP)}$ Peak-to-peak equivalent input noise voltage	f = 0.1 to 1 Hz	0.16			μ V
	f = 0.1 to 10 Hz	0.47			
I_n Equivalent input noise current		0.1			pA/ $\sqrt{\text{Hz}}$
B_1 Unity-gain bandwidth	See Figure 3	1.7			MHz
ϕ_m Phase margin at unity gain	See Figure 3	47°			

TLE2024 operating characteristics at specified free-air temperature, $V_{CC} = \pm 15$ V (unless otherwise noted)

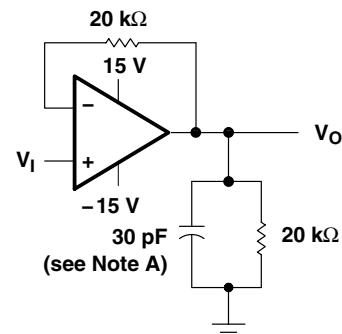
PARAMETER	TEST CONDITIONS	T_A^\dagger	MIN	TYP	MAX	UNIT
SR Slew rate at unity gain	$V_O = \pm 10$ V, See Figure 1	25°C	0.45	0.7		V/ μ s
		Full range	0.4			
V_n Equivalent input noise voltage (see Figure 2)	f = 10 Hz	25°C	19			nV/ $\sqrt{\text{Hz}}$
	f = 1 kHz	25°C	15			
$V_{N(PP)}$ Peak-to-peak equivalent input noise voltage	f = 0.1 to 1 Hz	25°C	0.16			μ V
	f = 0.1 to 10 Hz	25°C	0.47			
I_n Equivalent input noise current		25°C	0.1			pA/ $\sqrt{\text{Hz}}$
B_1 Unity-gain bandwidth	See Figure 3	25°C	2.8			MHz
ϕ_m Phase margin at unity gain	See Figure 3	25°C	52°			

† Full range is -40°C to 125°C.

PARAMETER MEASUREMENT INFORMATION



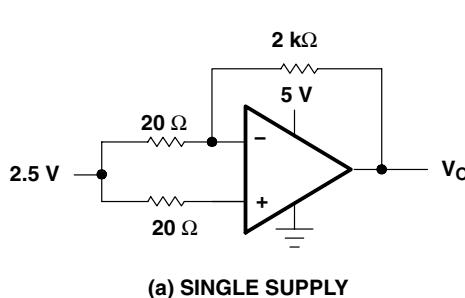
(a) SINGLE SUPPLY



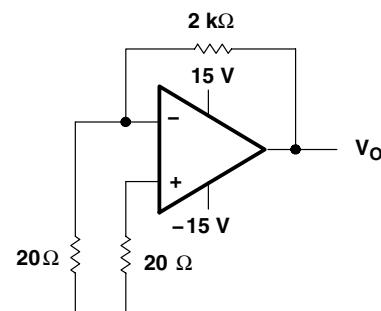
(b) SPLIT SUPPLY

NOTE A: C_L includes fixture capacitance.

Figure 1. Slew-Rate Test Circuit

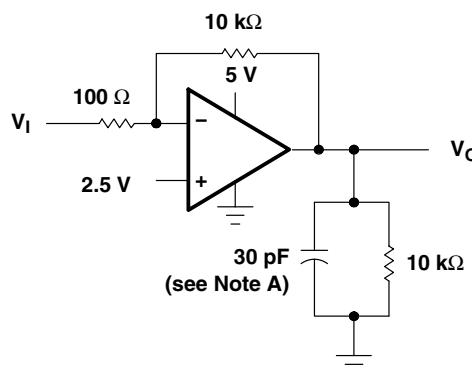


(a) SINGLE SUPPLY

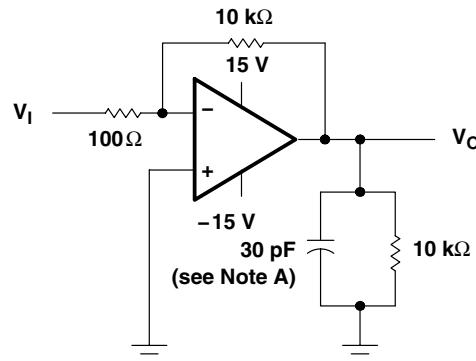


(b) SPLIT SUPPLY

Figure 2. Noise-Voltage Test Circuit



(a) SINGLE SUPPLY



(b) SPLIT SUPPLY

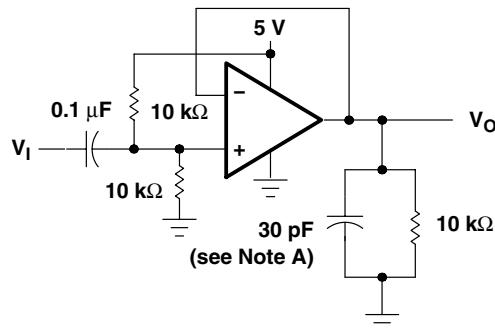
NOTE A: C_L includes fixture capacitance.

Figure 3. Unity-Gain Bandwidth and Phase-Margin Test Circuit

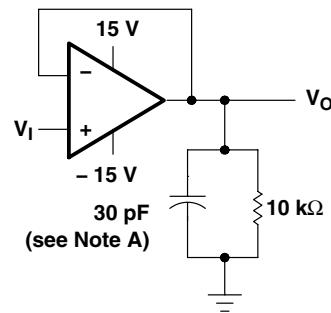
**TLE202x-Q1, TLE202xA-Q1
EXCALIBUR HIGH-SPEED LOW-POWER PRECISION
OPERATIONAL AMPLIFIERS**

SGLS199B – JANUARY 2004 – REVISED APRIL 2008

PARAMETER MEASUREMENT INFORMATION



(a) SINGLE SUPPLY



(b) SPLIT SUPPLY

NOTE A: C_L includes fixture capacitance.

Figure 4. Small-Signal Pulse-Response Test Circuit

typical values

Typical values presented in this data sheet represent the median (50% point) of device parametric performance.

TLE202x-Q1, TLE202xA-Q1
EXCALIBUR HIGH-SPEED LOW-POWER PRECISION
OPERATIONAL AMPLIFIERS

SGLS199B – JANUARY 2004 – REVISED APRIL 2008

TYPICAL CHARACTERISTICS

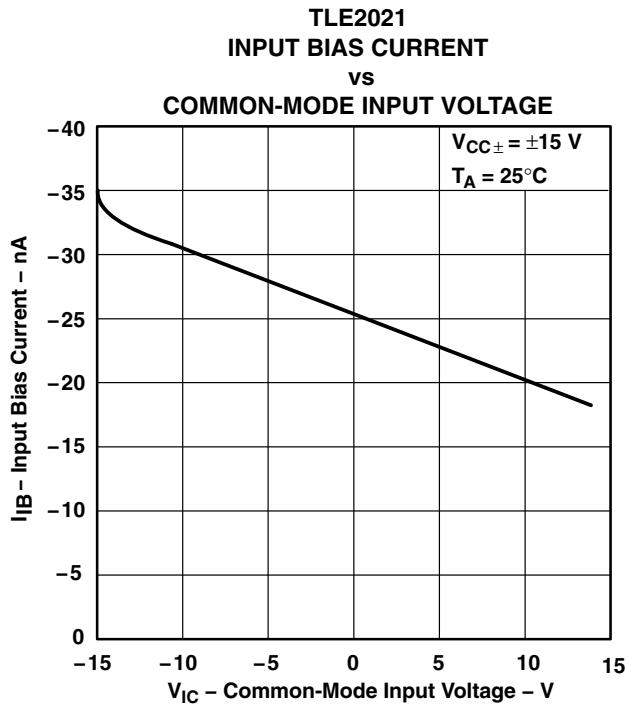
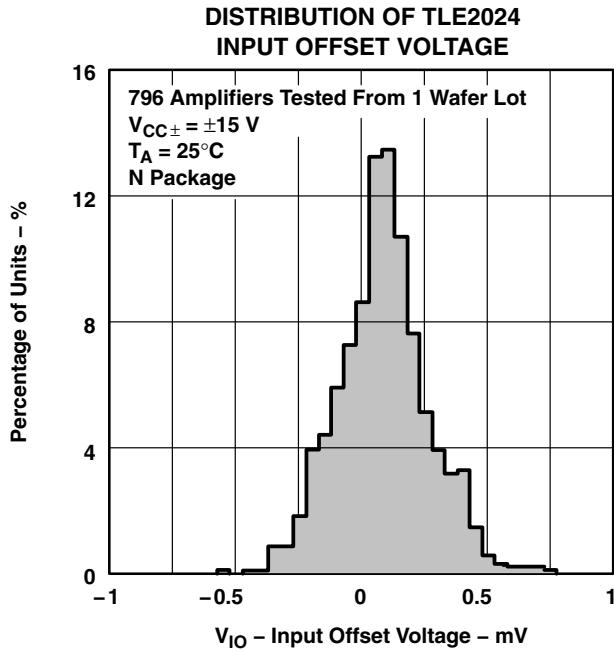
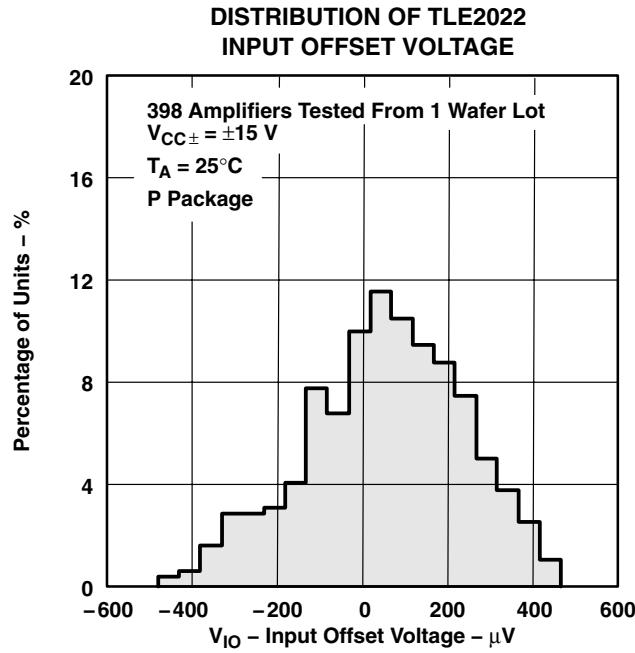
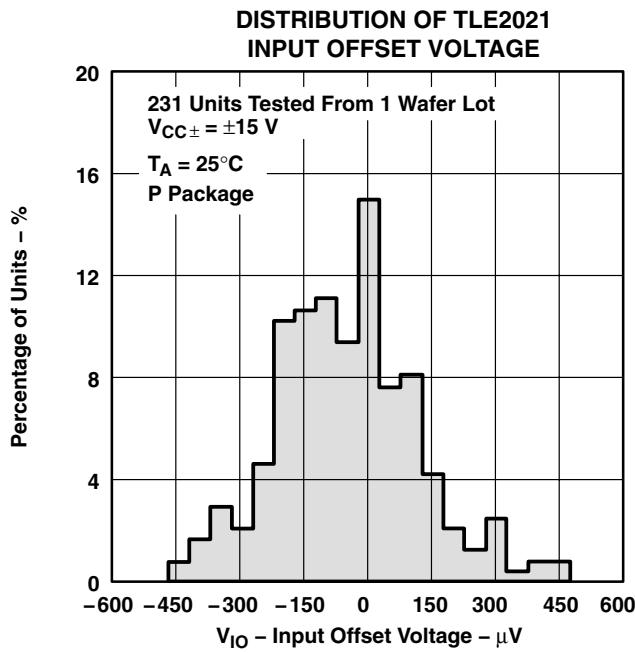
Table of Graphs

		FIGURE
V_{IO}	Input offset voltage	Distribution 5, 6, 7
I_{IB}	Input bias current	vs Common-mode input voltage 8, 9, 10 vs Free-air temperature 11, 12, 13
I_I	Input current	vs Differential input voltage 14
V_{OM}	Maximum peak output voltage	vs Output current 15, 16, 17 vs Free-air temperature 18
V_{OH}	High-level output voltage	vs High-level output current 19, 20 vs Free-air temperature 21
V_{OL}	Low-level output voltage	vs Low-level output current 22 vs Free-air temperature 23
$V_{O(PP)}$	Maximum peak-to-peak output voltage	vs Frequency 24, 25
A_{VD}	Large-signal differential voltage amplification	vs Frequency 26 vs Free-air temperature 27, 28, 29
I_{OS}	Short-circuit output current	vs Supply voltage 30 – 33 vs Free-air temperature 34 – 37
I_{CC}	Supply current	vs Supply voltage 38, 39, 40 vs Free-air temperature 41, 42, 43
CMRR	Common-mode rejection ratio	vs Frequency 44, 45, 46
SR	Slew rate	vs Free-air temperature 47, 48, 49
	Voltage-follower small-signal pulse response	50, 51
	Voltage-follower large-signal pulse response	52 – 57
$V_{N(PP)}$	Peak-to-peak equivalent input noise voltage	0.1 to 1 Hz 58 0.1 to 10 Hz 59
V_n	Equivalent input noise voltage	vs Frequency 60
B_1	Unity-gain bandwidth	vs Supply voltage 61, 62 vs Free-air temperature 63, 64
ϕ_m	Phase margin	vs Supply voltage 65, 66 vs Load capacitance 67, 68 vs Free-air temperature 69, 70
	Phase shift	vs Frequency 26

**TLE202x-Q1, TLE202xA-Q1
EXCALIBUR HIGH-SPEED LOW-POWER PRECISION
OPERATIONAL AMPLIFIERS**

SGLS199B – JANUARY 2004 – REVISED APRIL 2008

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

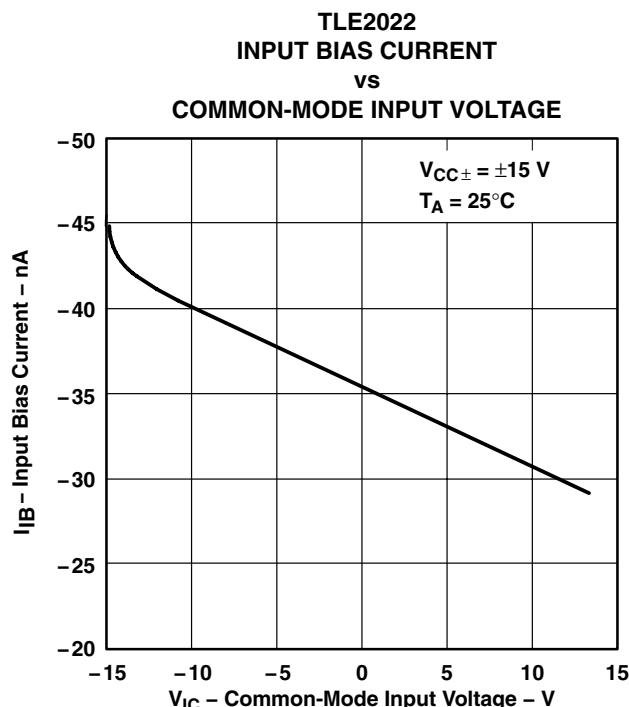


Figure 9

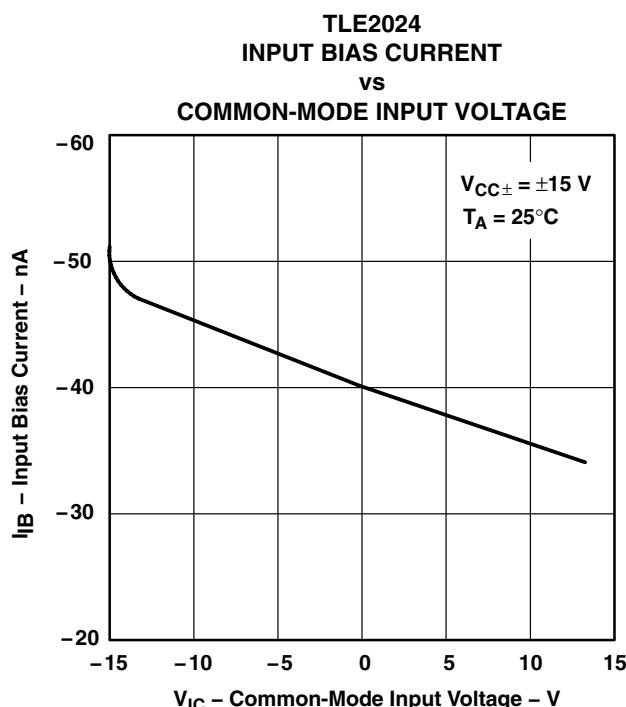


Figure 10

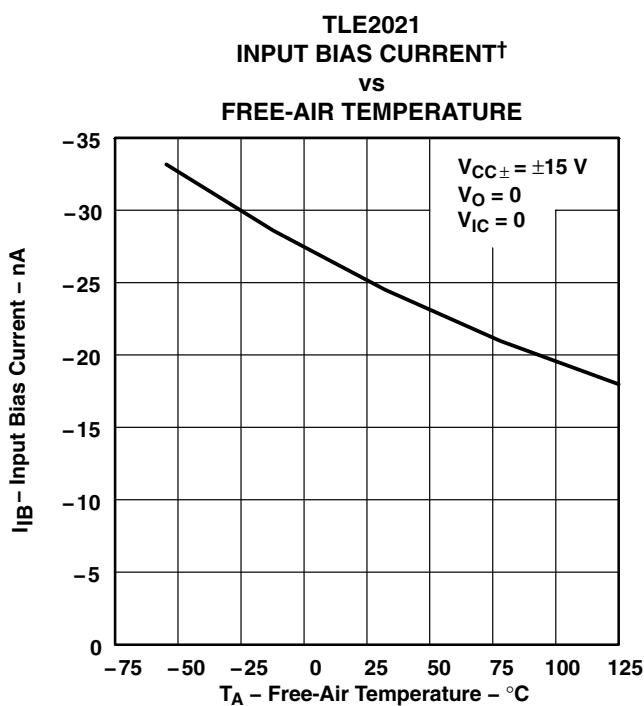


Figure 11

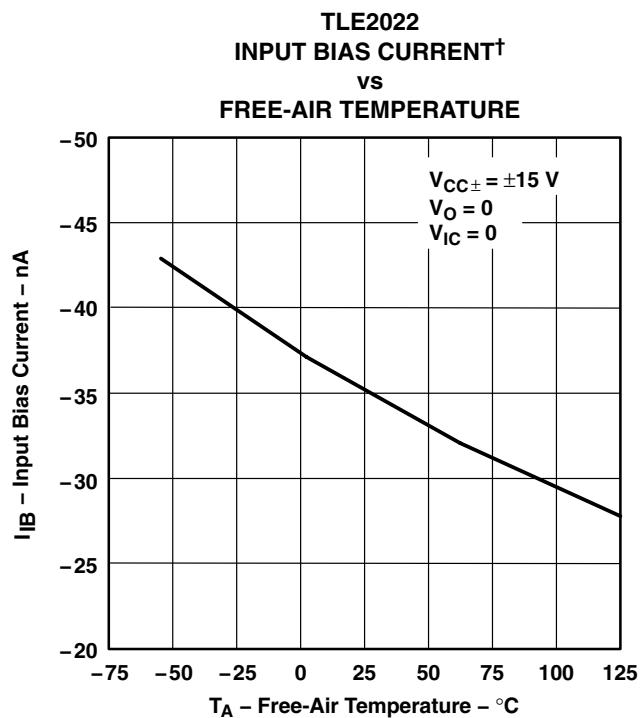


Figure 12

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

**TLE202x-Q1, TLE202xA-Q1
EXCALIBUR HIGH-SPEED LOW-POWER PRECISION
OPERATIONAL AMPLIFIERS**

SGLS199B – JANUARY 2004 – REVISED APRIL 2008

TYPICAL CHARACTERISTICS

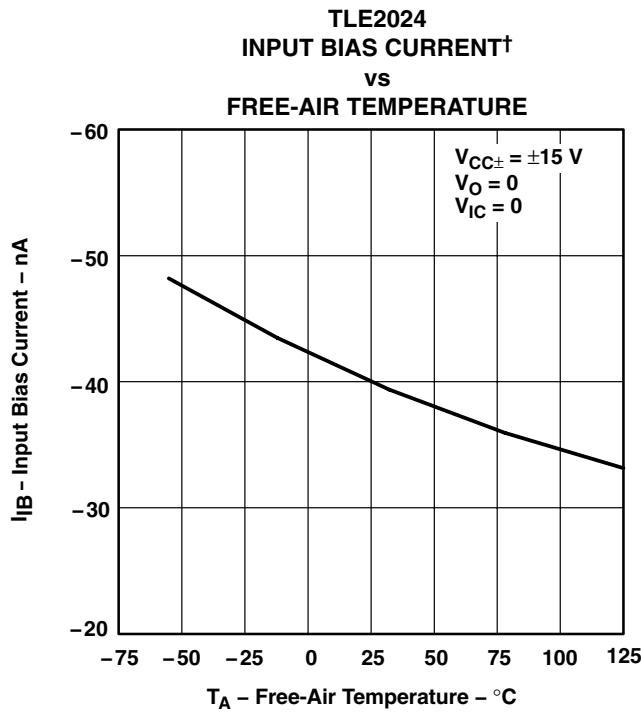


Figure 13

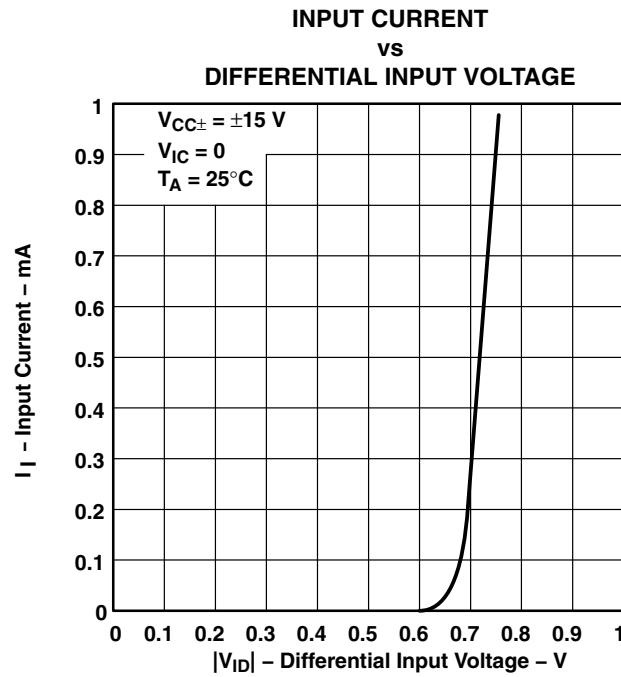


Figure 14

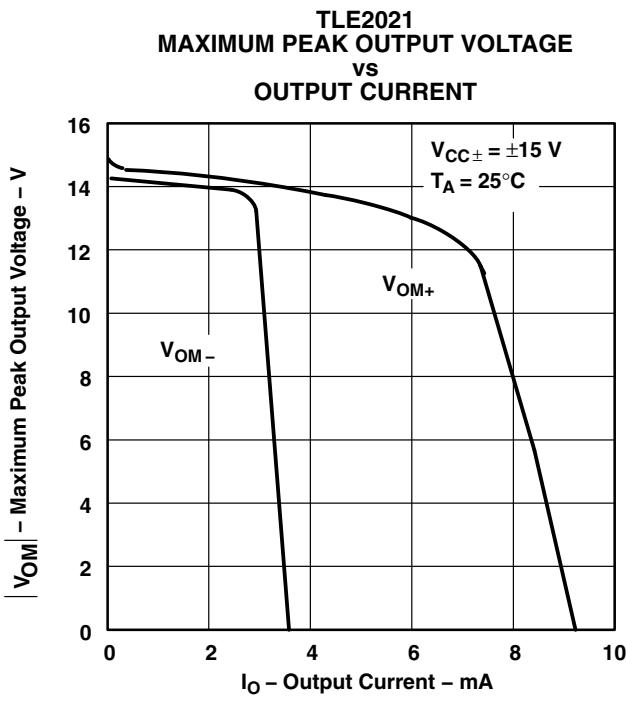


Figure 15

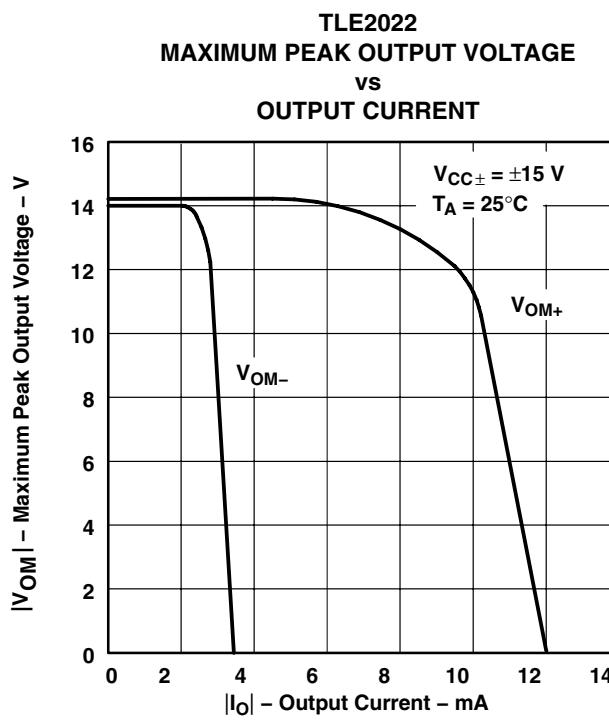


Figure 16

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

TYPICAL CHARACTERISTICS

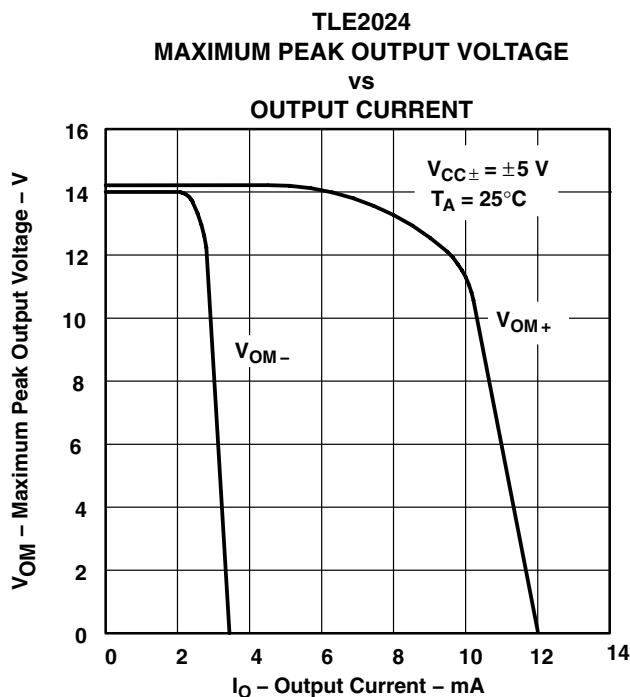


Figure 17

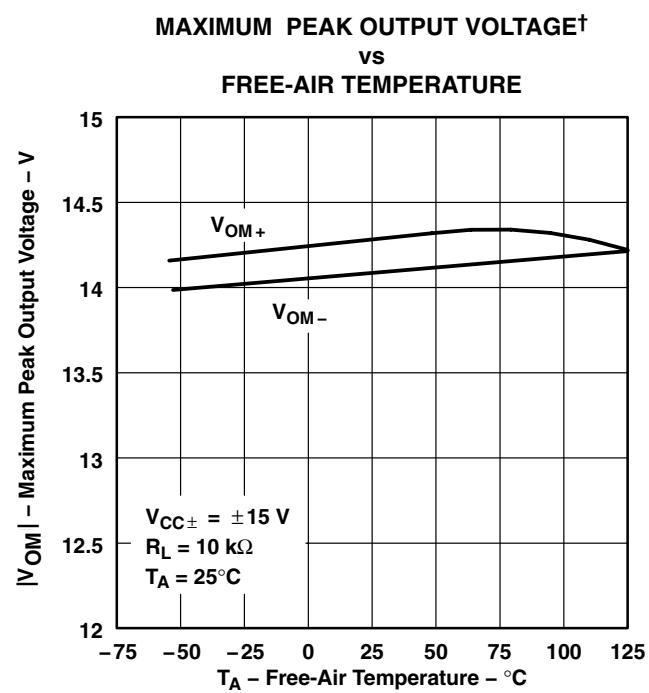


Figure 18

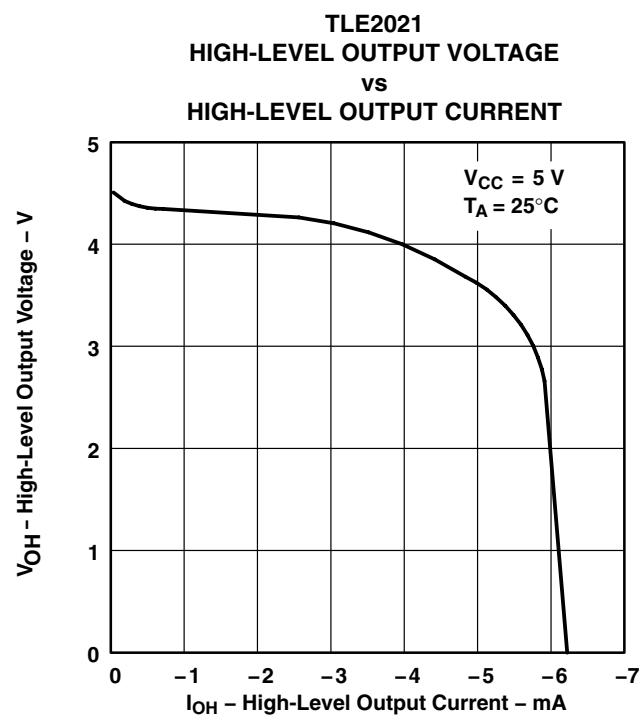


Figure 19

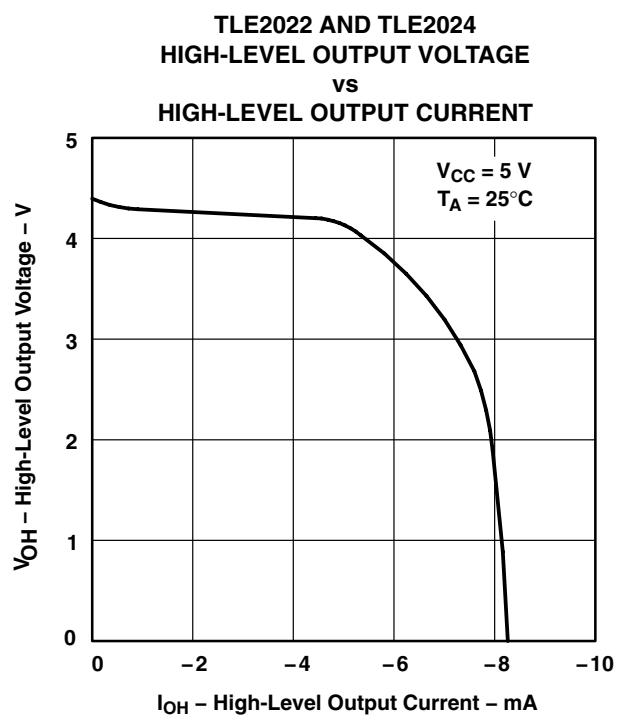


Figure 20

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

**TLE202x-Q1, TLE202xA-Q1
EXCALIBUR HIGH-SPEED LOW-POWER PRECISION
OPERATIONAL AMPLIFIERS**

SGS199B – JANUARY 2004 – REVISED APRIL 2008

TYPICAL CHARACTERISTICS

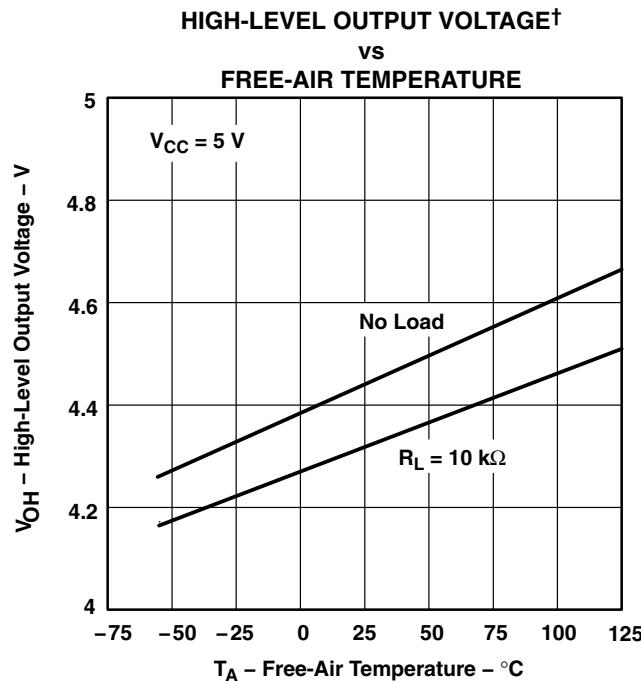


Figure 21

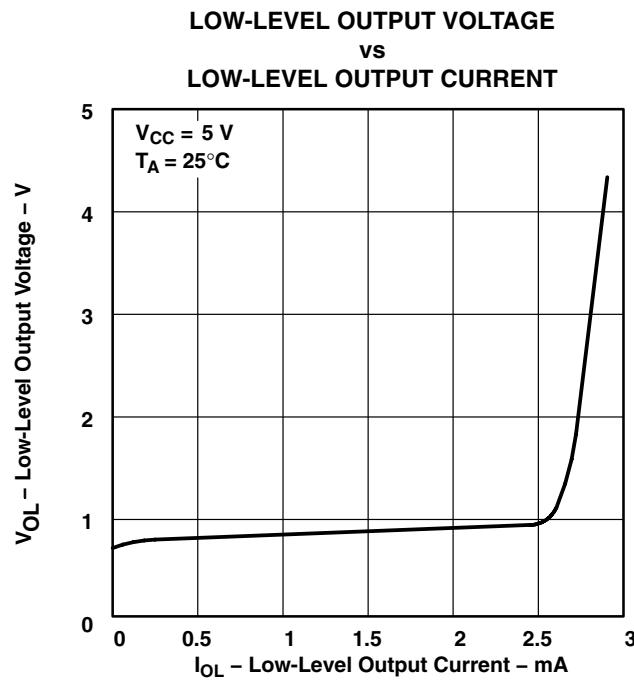


Figure 22

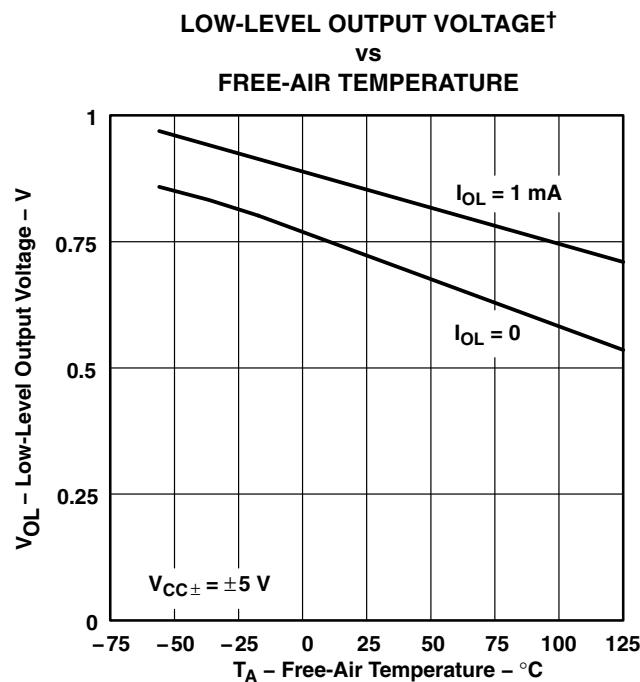


Figure 23

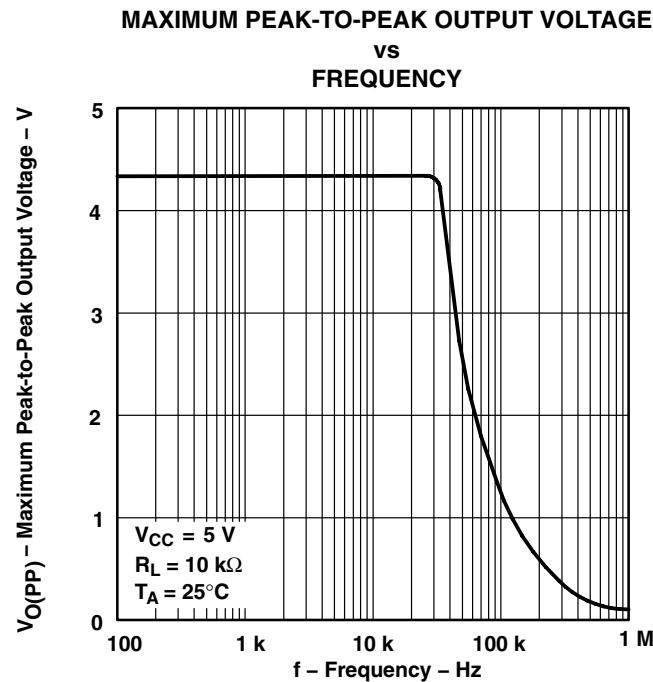


Figure 24

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

TYPICAL CHARACTERISTICS

**MAXIMUM PEAK-TO-PEAK OUTPUT VOLTAGE
 vs
 FREQUENCY**

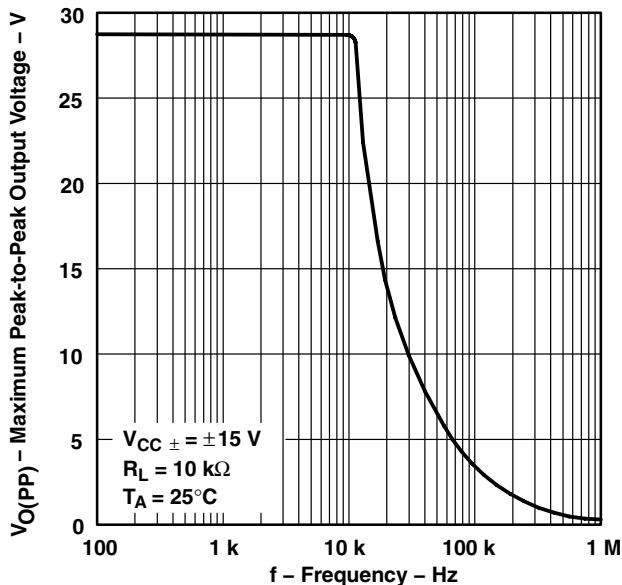


Figure 25

**LARGE-SIGNAL DIFFERENTIAL VOLTAGE
 AMPLIFICATION AND PHASE SHIFT
 vs
 FREQUENCY**

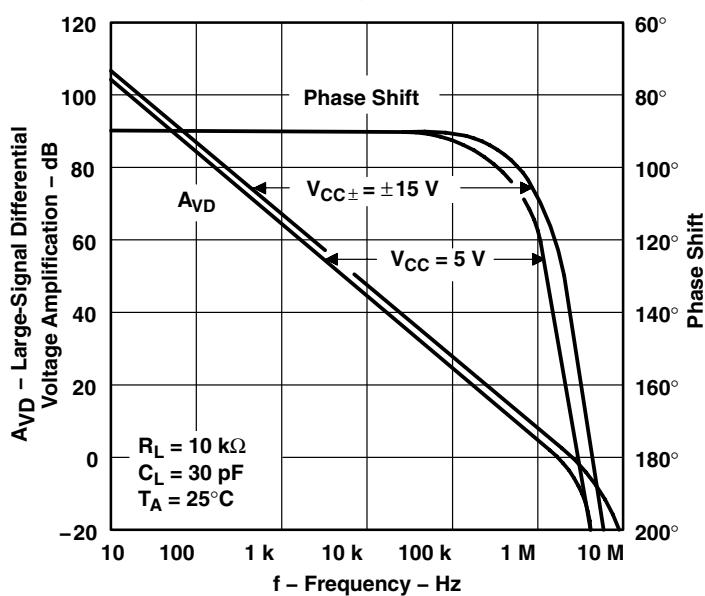


Figure 26

**TLE202x-Q1, TLE202xA-Q1
EXCALIBUR HIGH-SPEED LOW-POWER PRECISION
OPERATIONAL AMPLIFIERS**

SGLS199B – JANUARY 2004 – REVISED APRIL 2008

TYPICAL CHARACTERISTICS

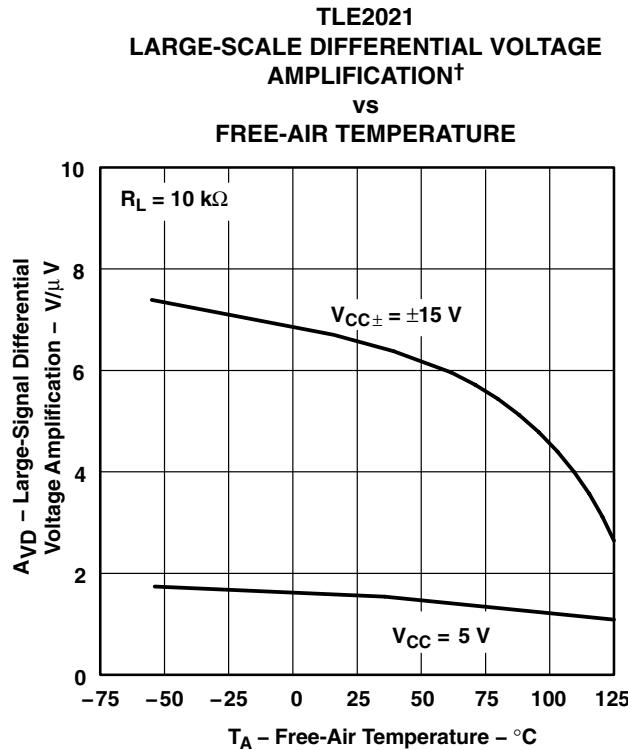


Figure 27

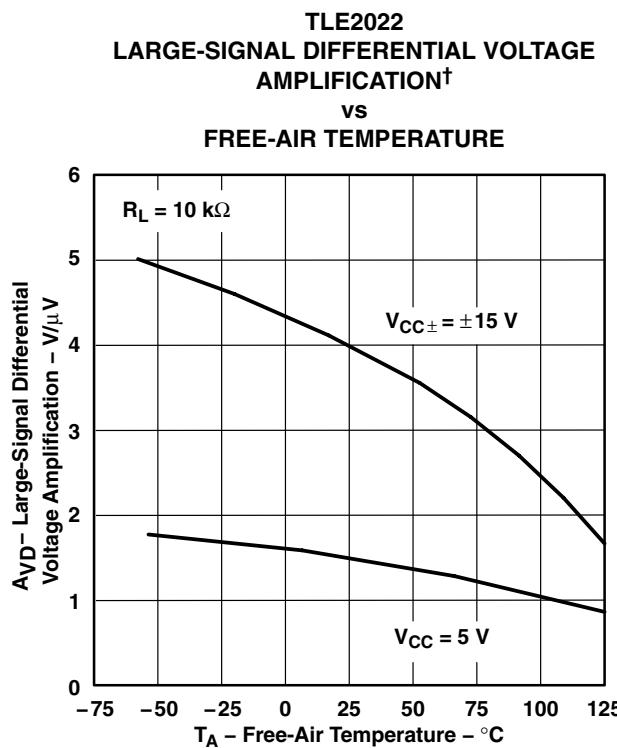


Figure 28

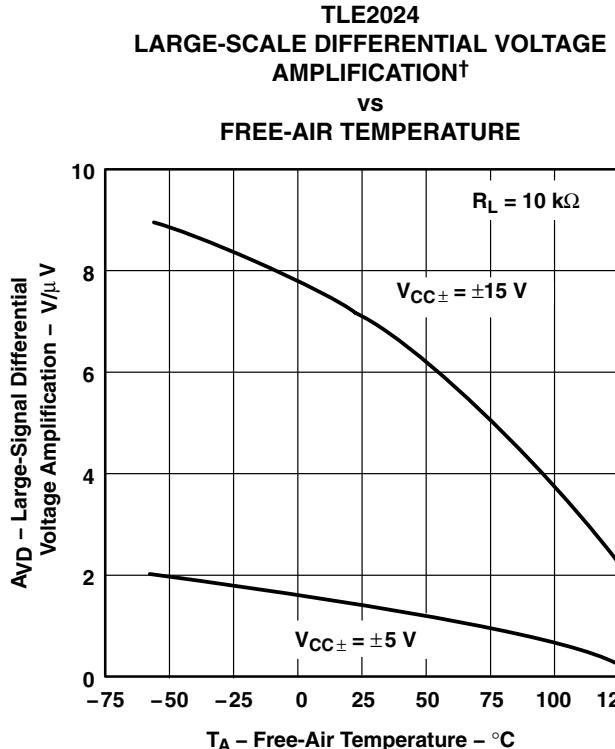


Figure 29

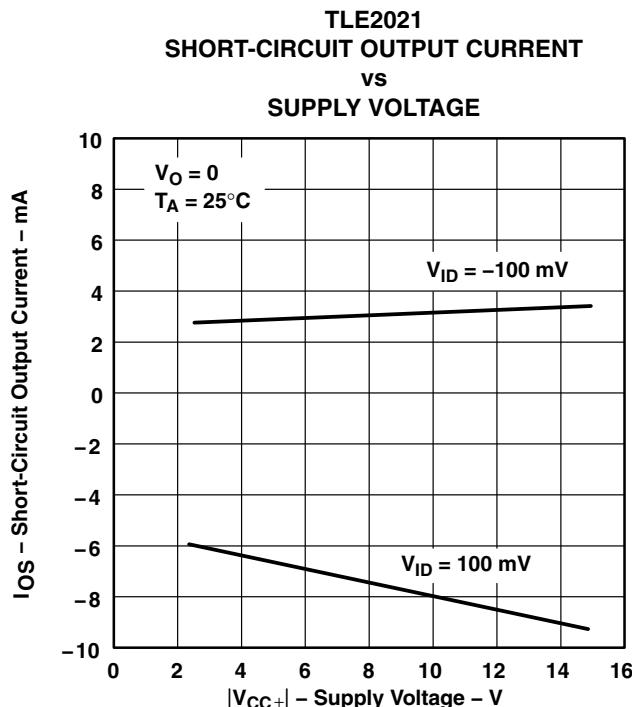


Figure 30

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

TYPICAL CHARACTERISTICS

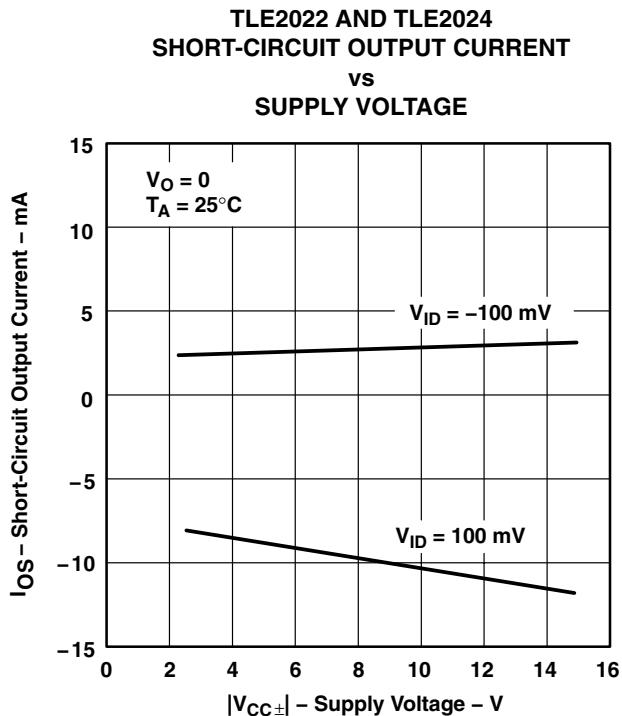


Figure 31

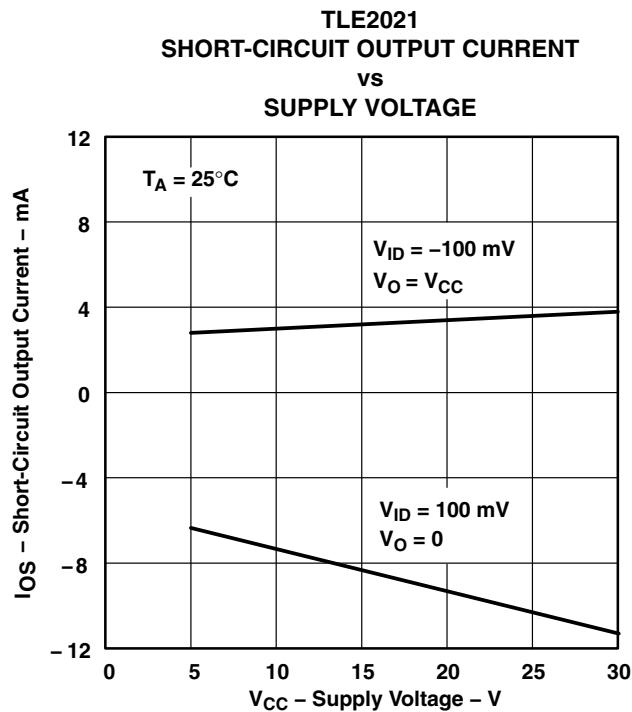


Figure 32

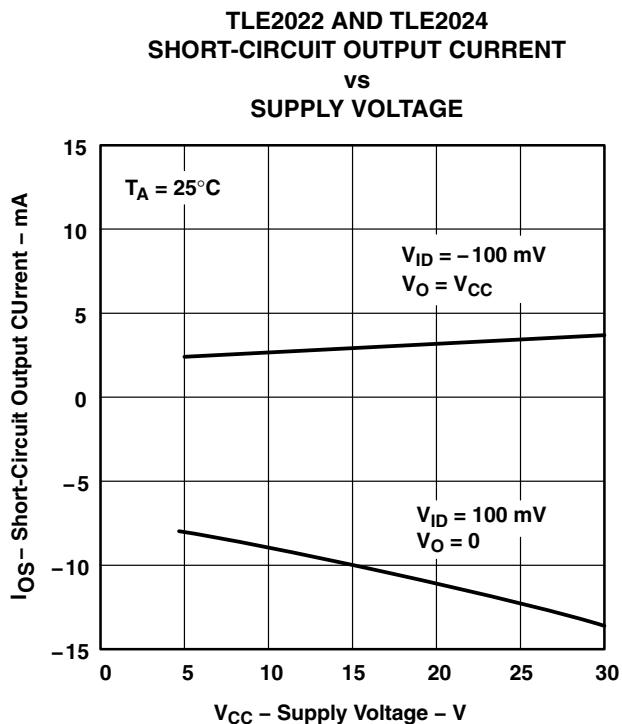


Figure 33

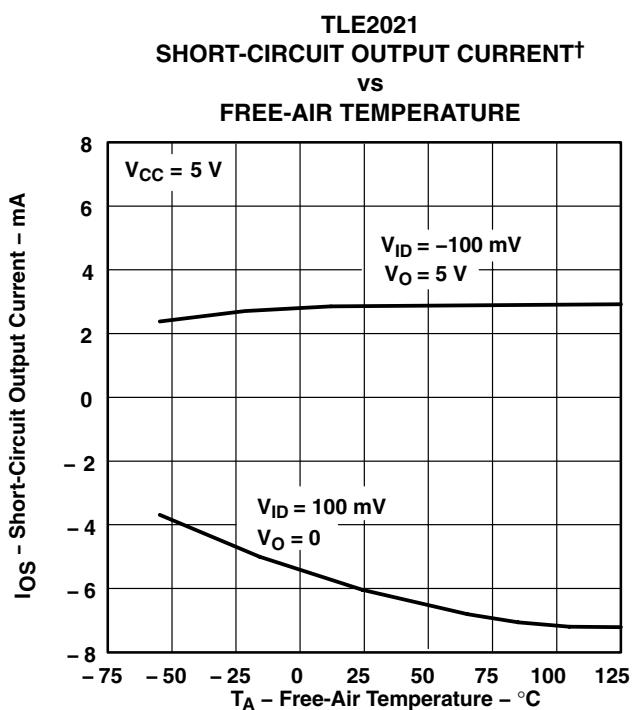


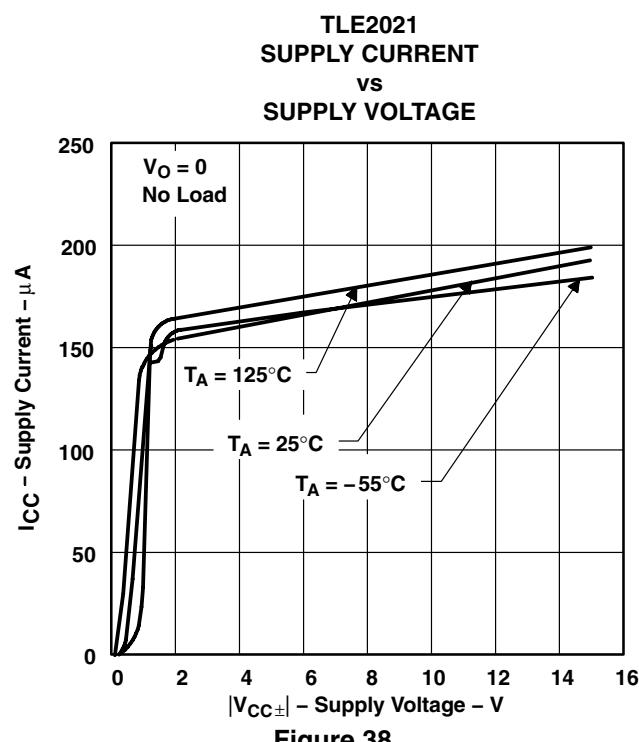
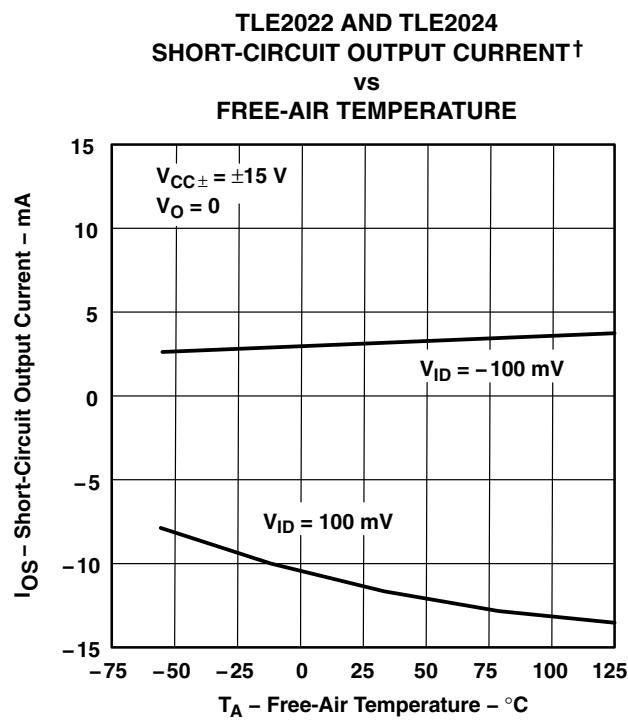
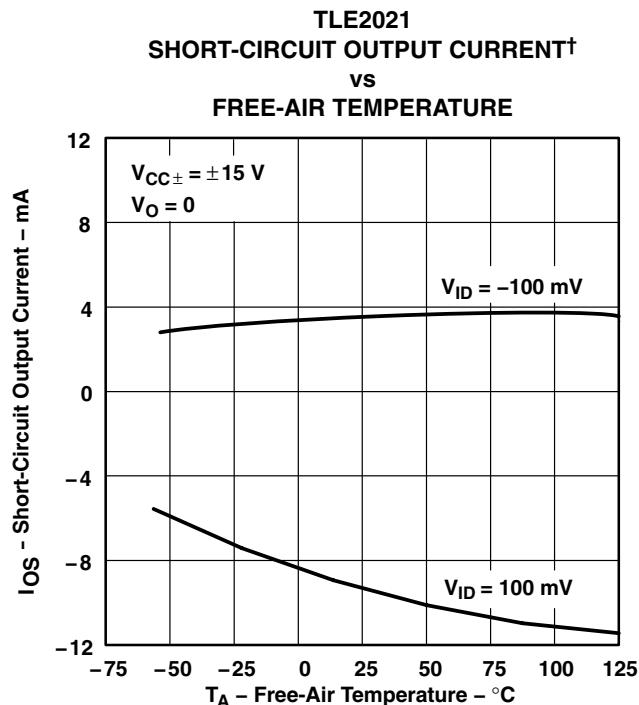
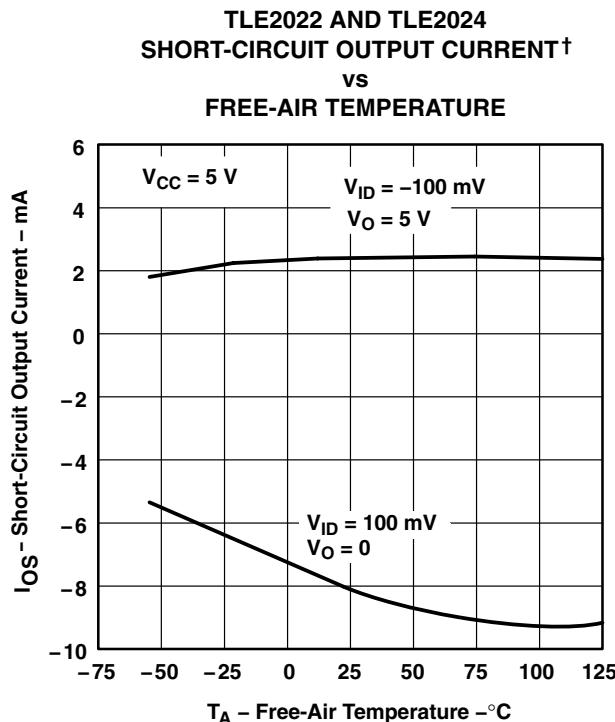
Figure 34

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

**TLE202x-Q1, TLE202xA-Q1
EXCALIBUR HIGH-SPEED LOW-POWER PRECISION
OPERATIONAL AMPLIFIERS**

SGLS199B – JANUARY 2004 – REVISED APRIL 2008

TYPICAL CHARACTERISTICS



[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

TYPICAL CHARACTERISTICS

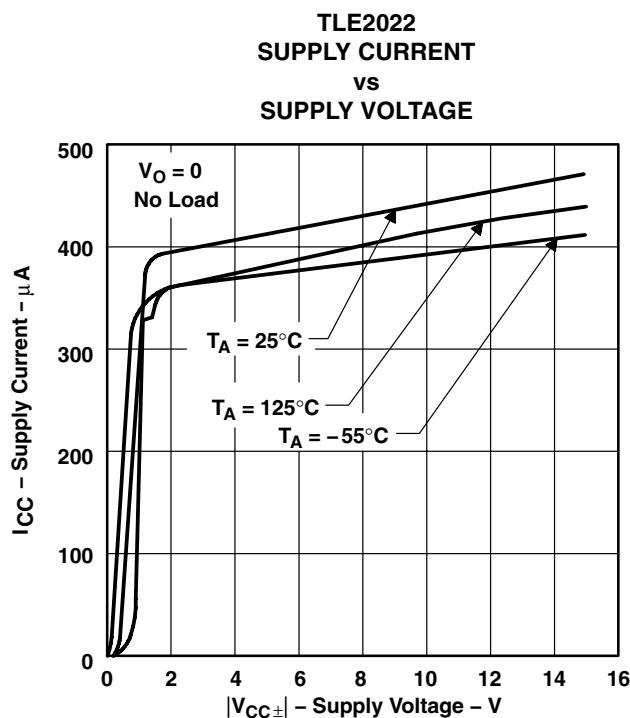


Figure 39

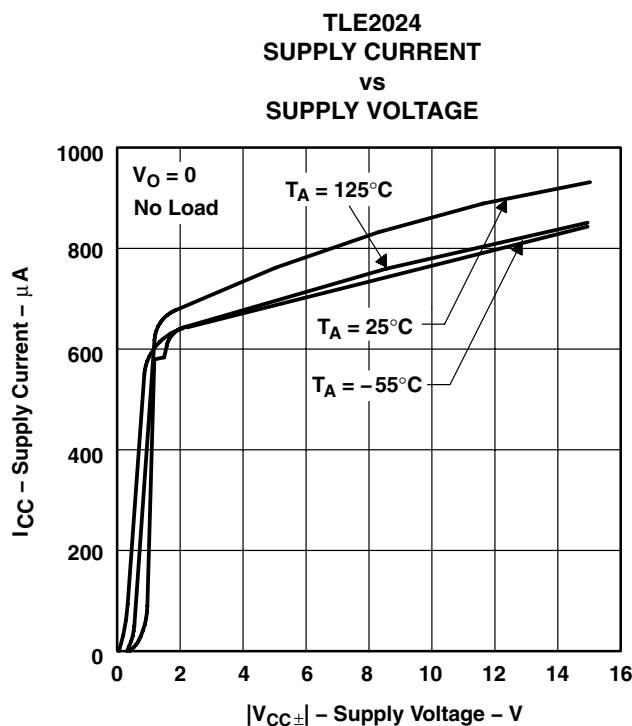


Figure 40

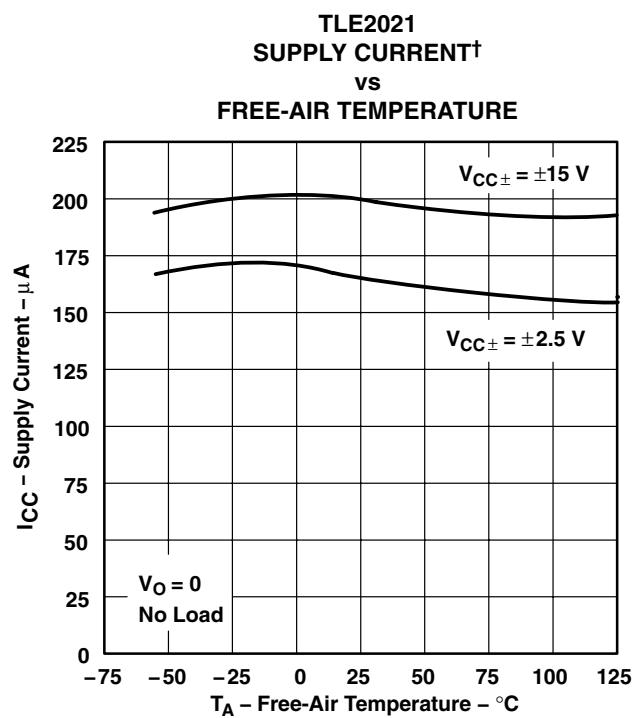


Figure 41

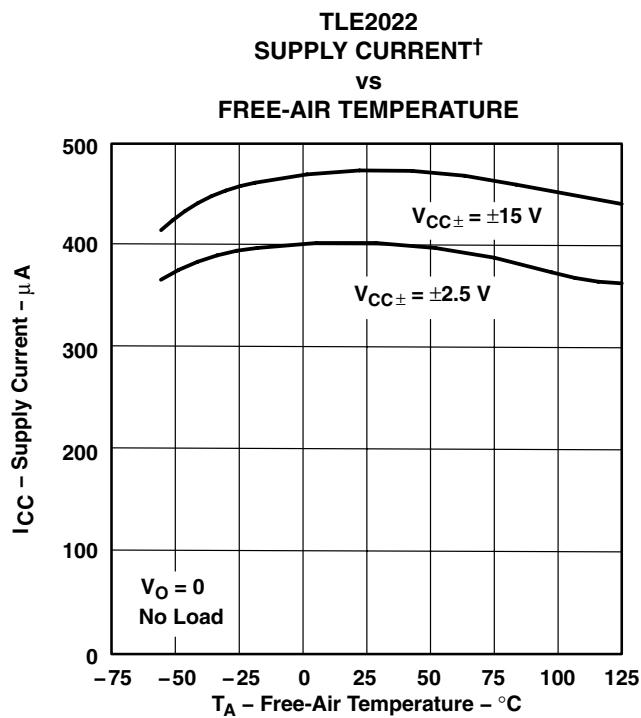


Figure 42

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

**TLE202x-Q1, TLE202xA-Q1
EXCALIBUR HIGH-SPEED LOW-POWER PRECISION
OPERATIONAL AMPLIFIERS**

SGLS199B – JANUARY 2004 – REVISED APRIL 2008

TYPICAL CHARACTERISTICS

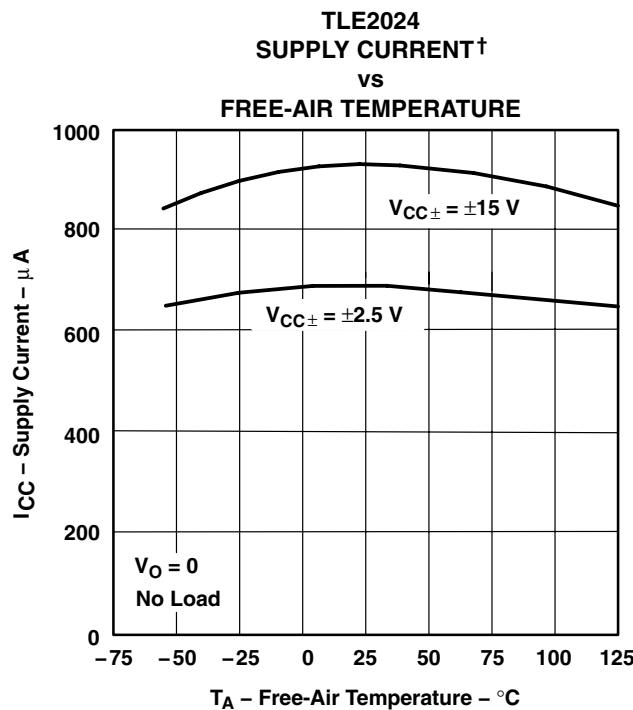


Figure 43

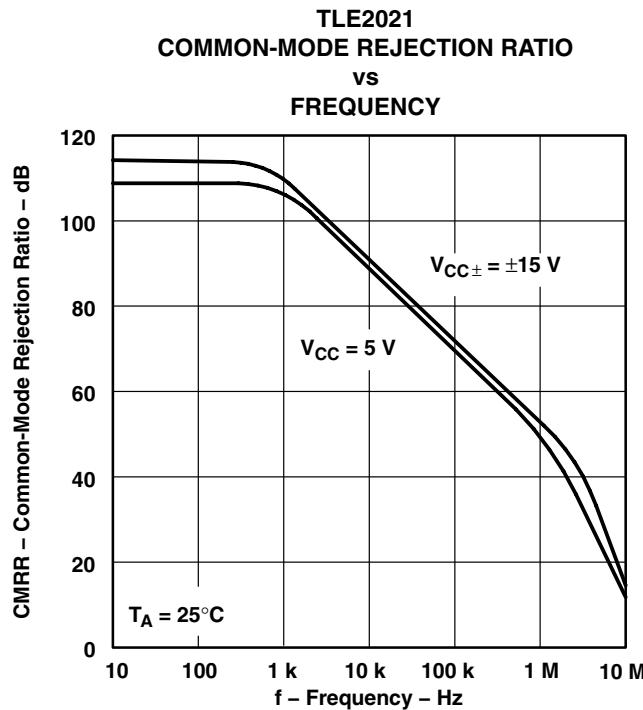


Figure 44

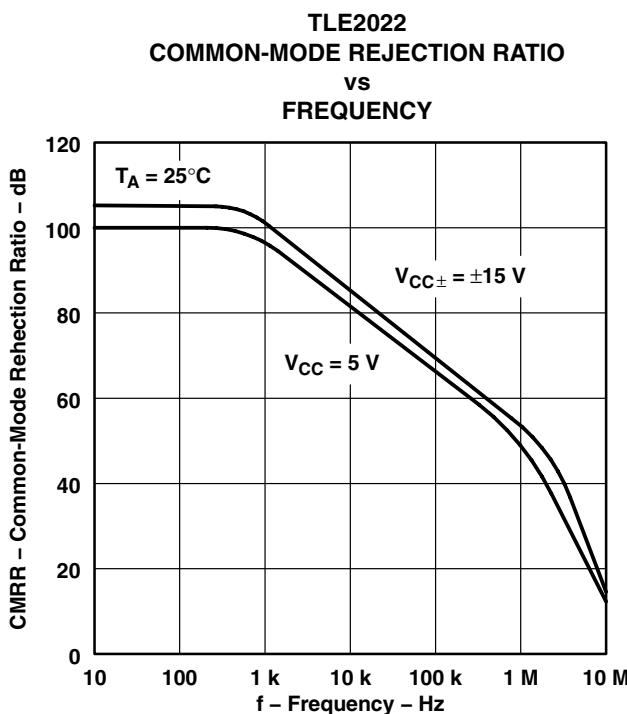


Figure 45

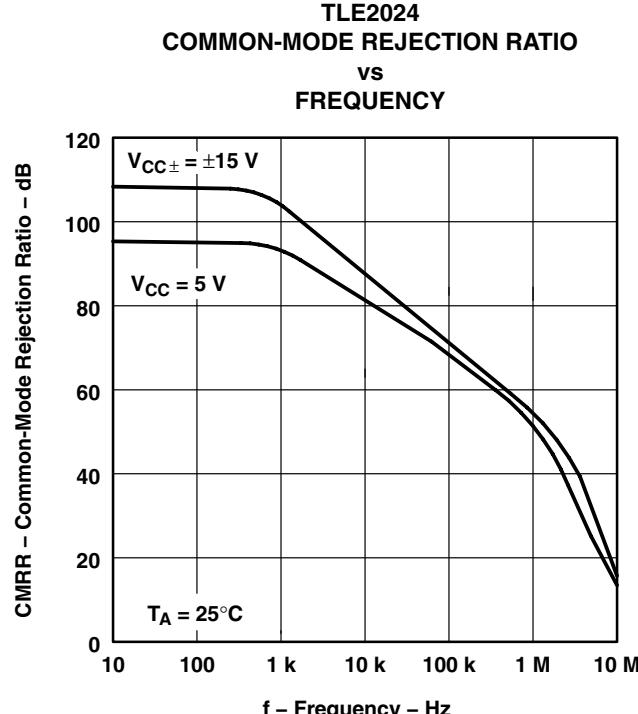


Figure 46

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

TYPICAL CHARACTERISTICS

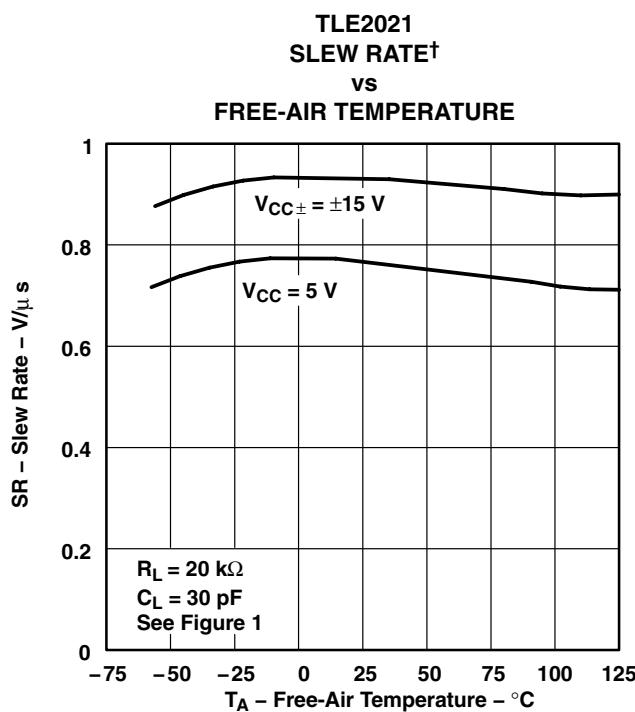


Figure 47

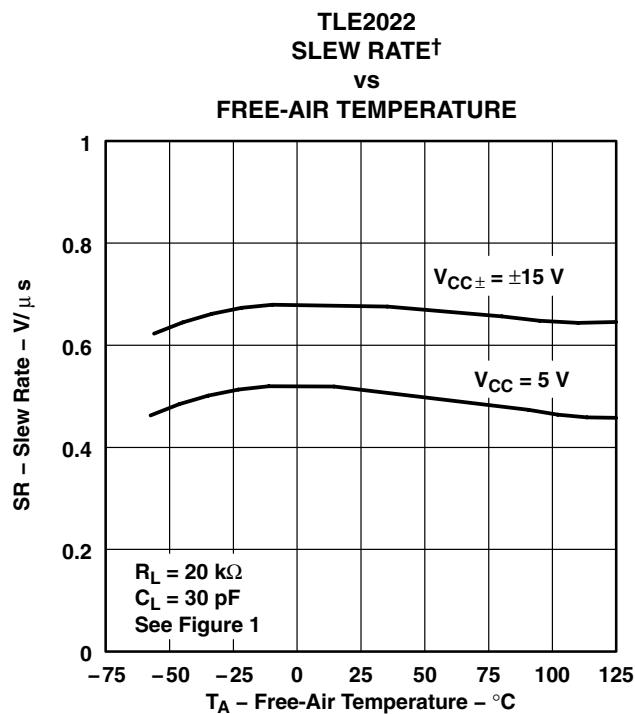


Figure 48

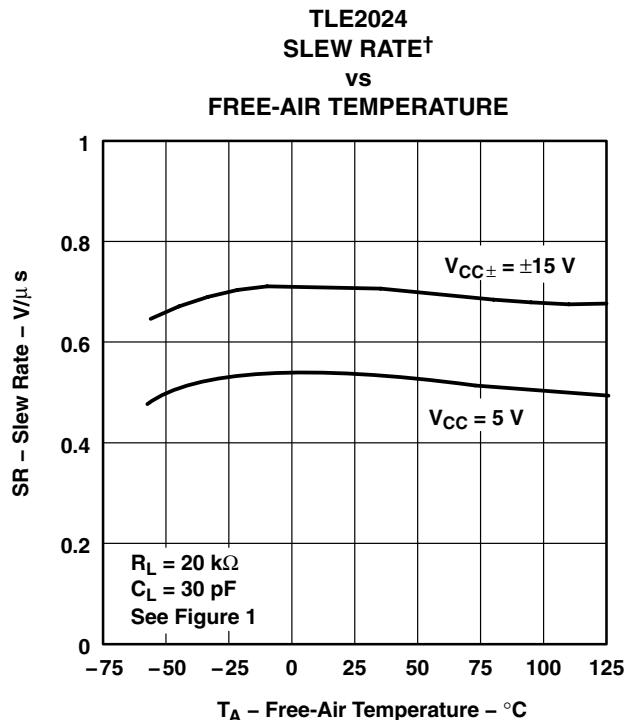


Figure 49

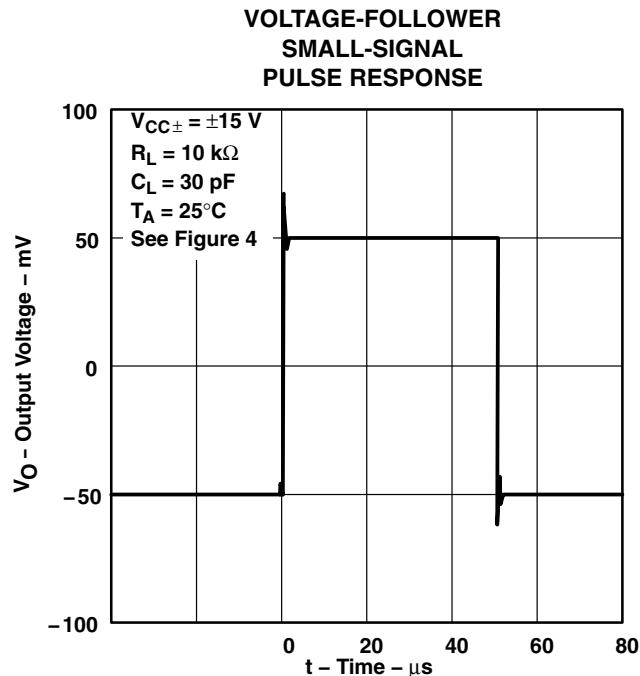


Figure 50

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

**TLE202x-Q1, TLE202xA-Q1
EXCALIBUR HIGH-SPEED LOW-POWER PRECISION
OPERATIONAL AMPLIFIERS**

SGLS199B – JANUARY 2004 – REVISED APRIL 2008

TYPICAL CHARACTERISTICS

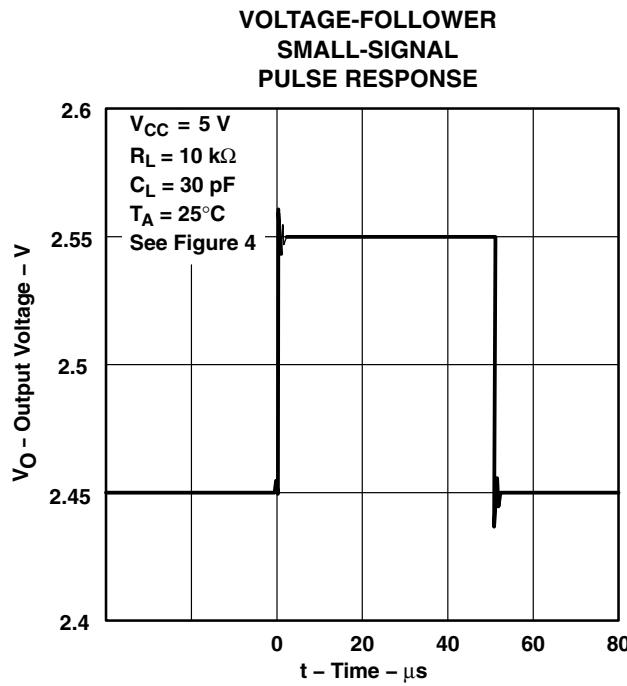


Figure 51

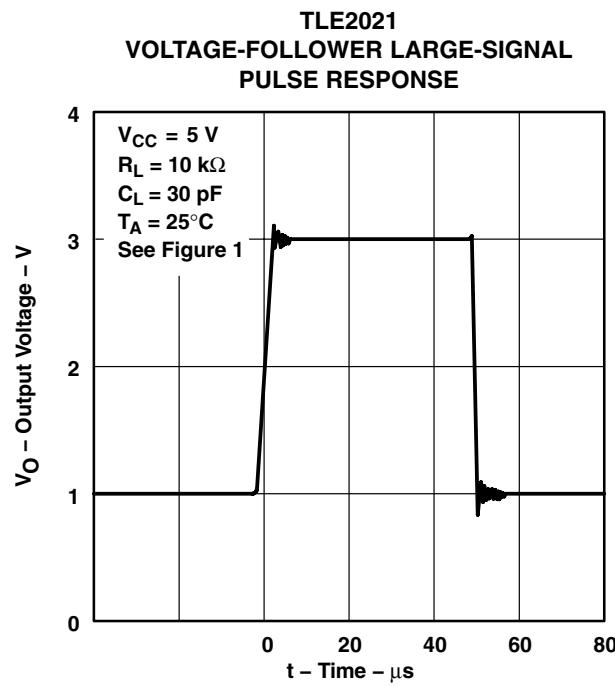


Figure 52

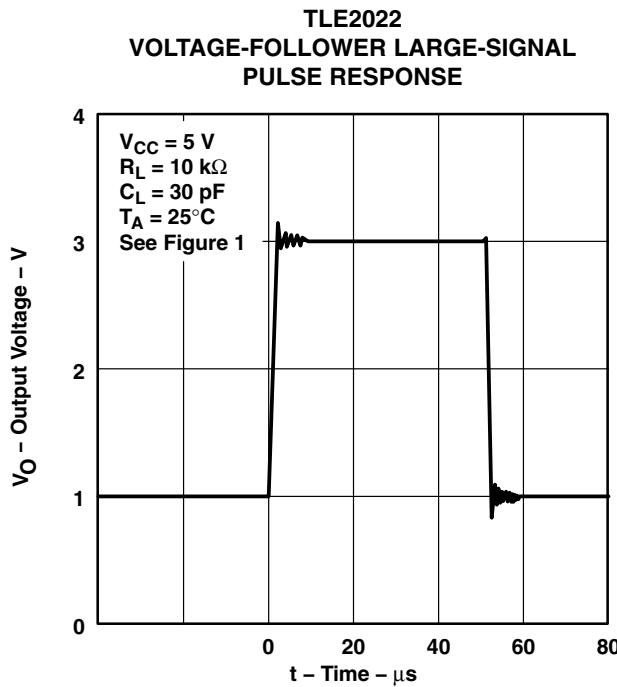


Figure 53

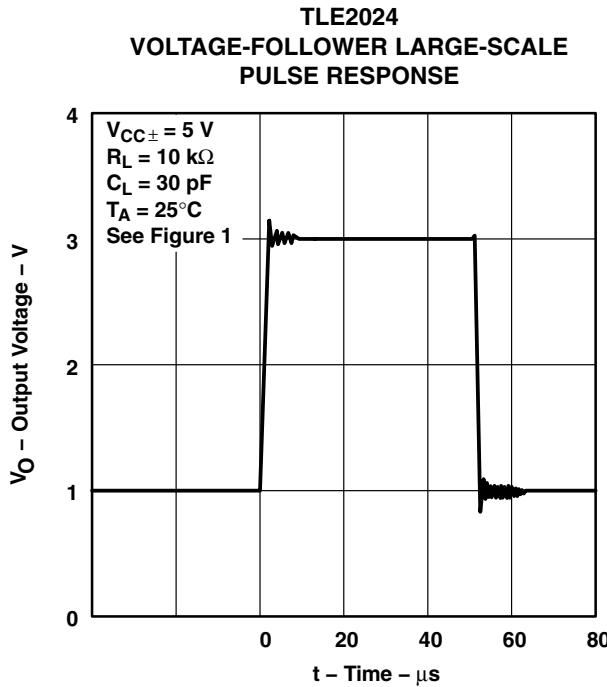


Figure 54

TYPICAL CHARACTERISTICS

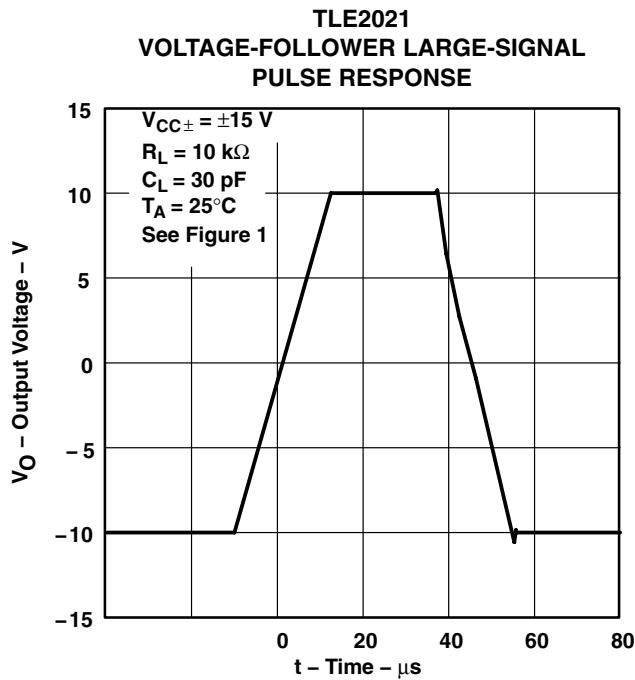


Figure 55

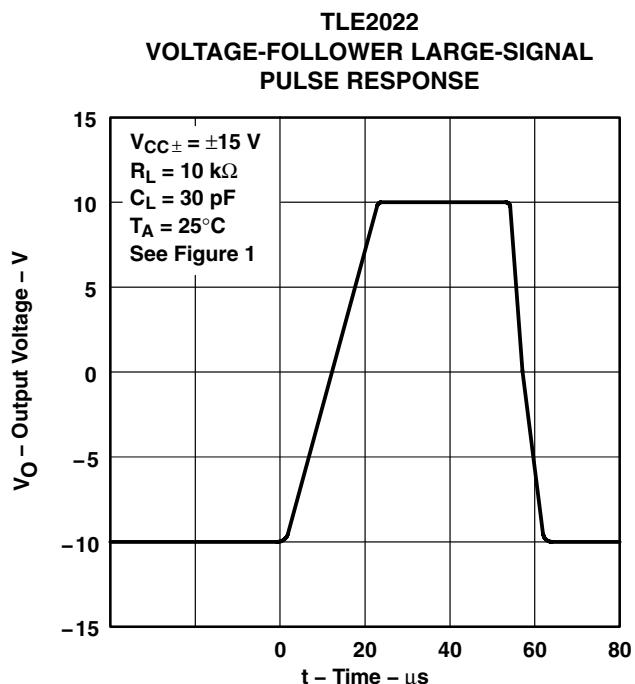


Figure 56

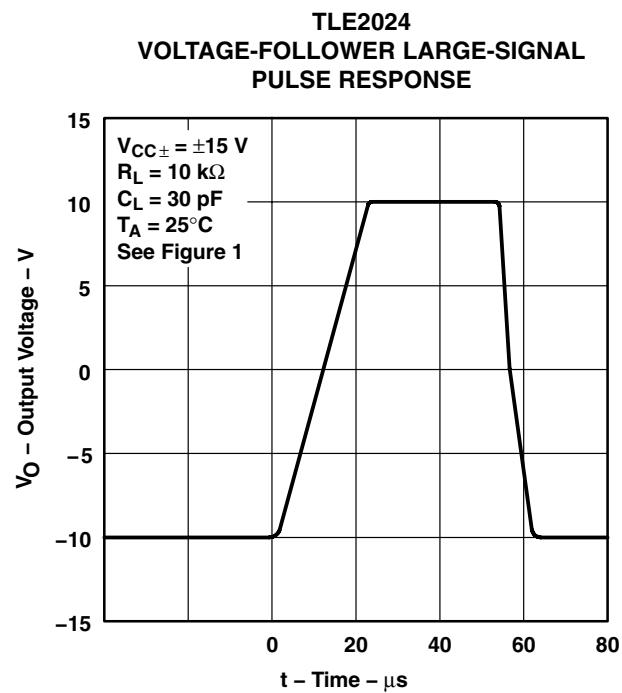


Figure 57

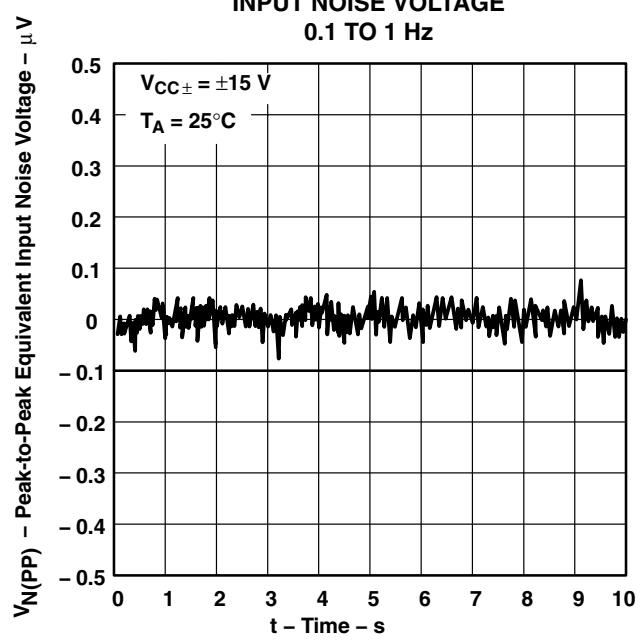


Figure 58

**TLE202x-Q1, TLE202xA-Q1
EXCALIBUR HIGH-SPEED LOW-POWER PRECISION
OPERATIONAL AMPLIFIERS**

SGLS199B – JANUARY 2004 – REVISED APRIL 2008

TYPICAL CHARACTERISTICS

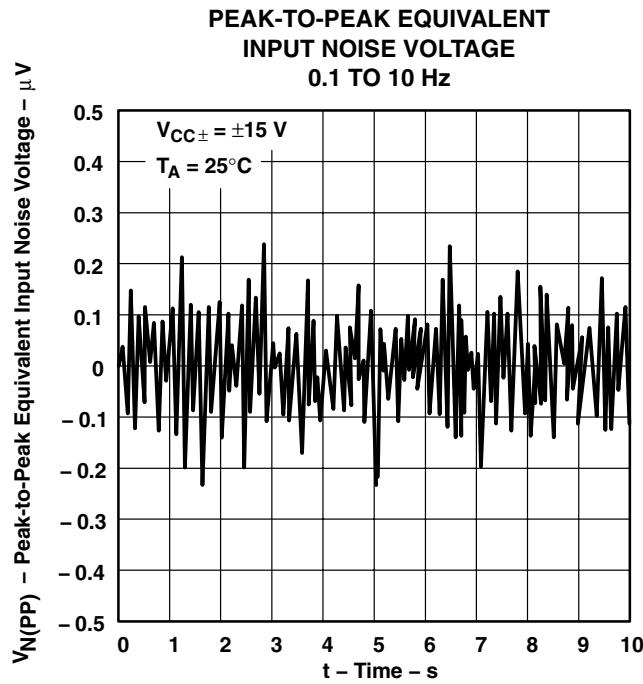


Figure 59

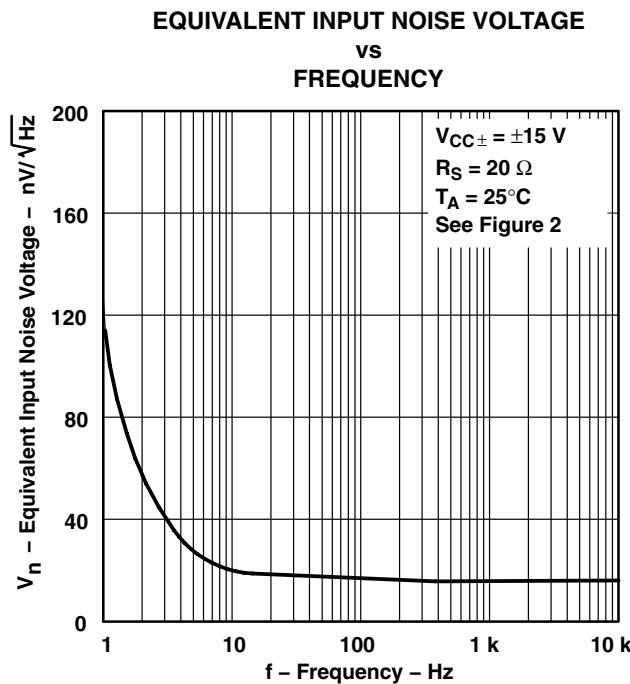


Figure 60

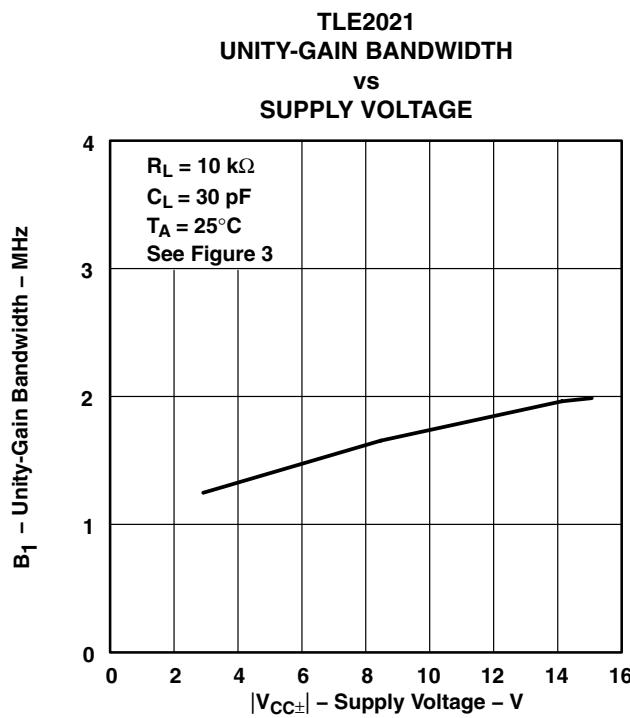


Figure 61

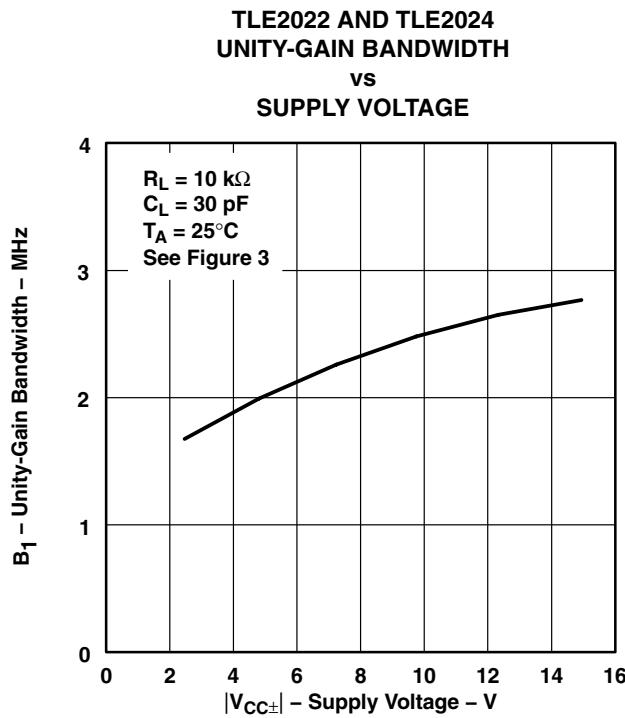


Figure 62

TYPICAL CHARACTERISTICS

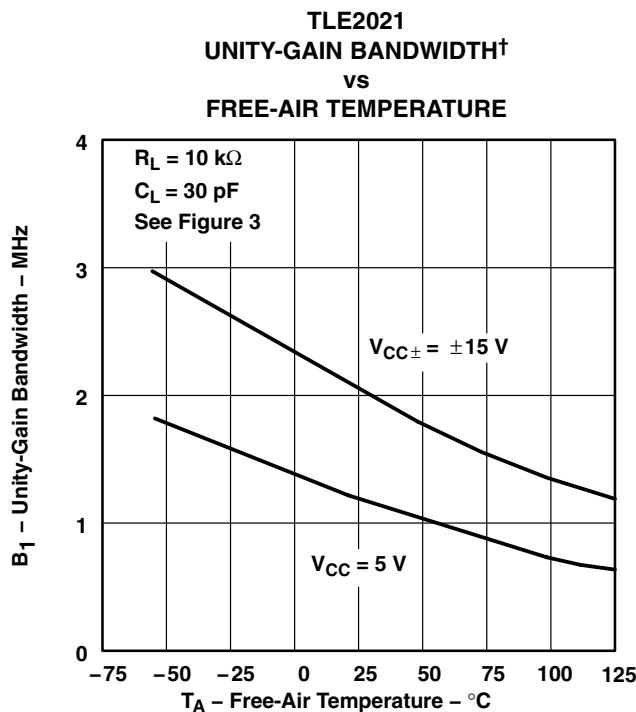


Figure 63

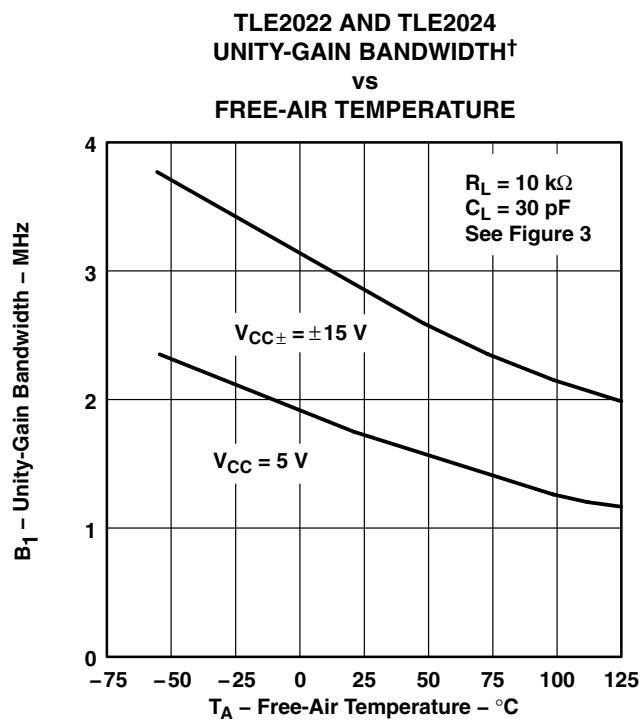


Figure 64

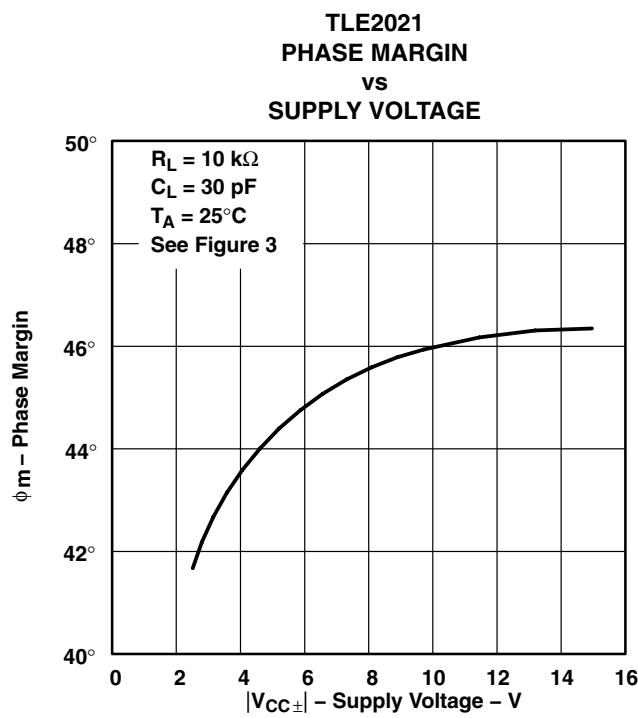


Figure 65

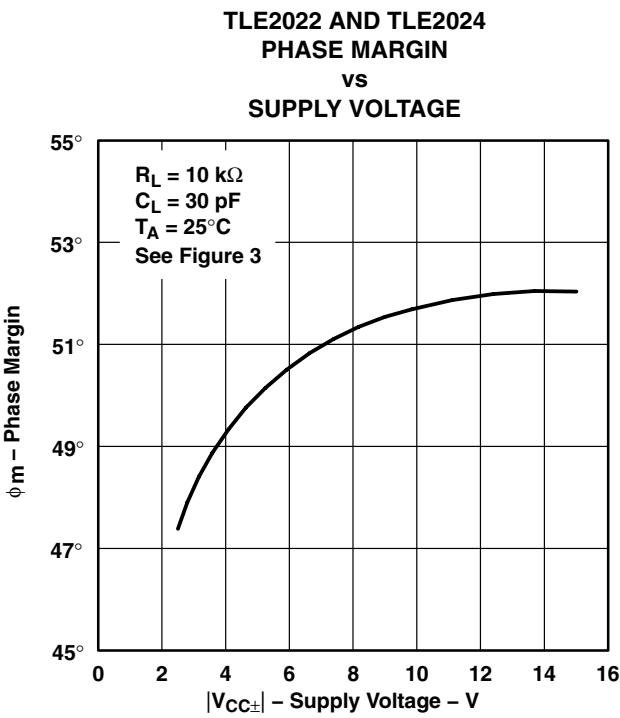


Figure 66

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

**TLE202x-Q1, TLE202xA-Q1
EXCALIBUR HIGH-SPEED LOW-POWER PRECISION
OPERATIONAL AMPLIFIERS**

SGLS199B – JANUARY 2004 – REVISED APRIL 2008

TYPICAL CHARACTERISTICS

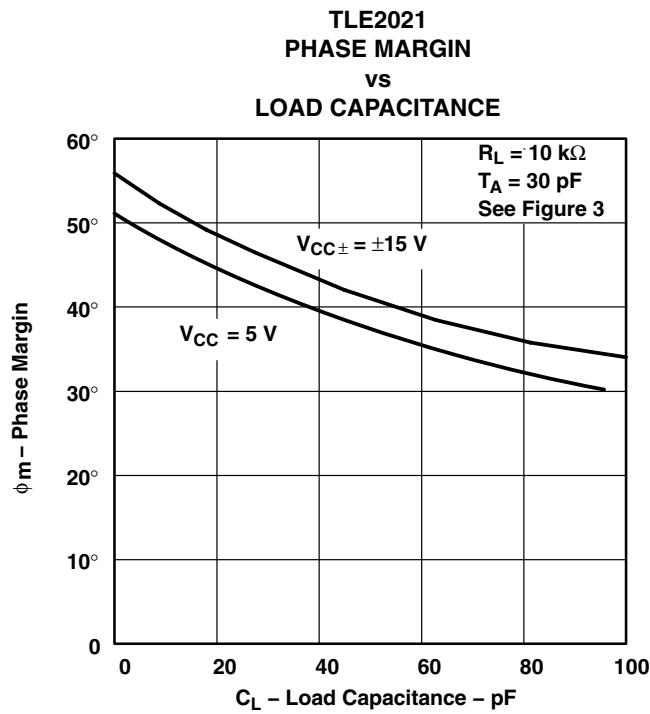


Figure 67

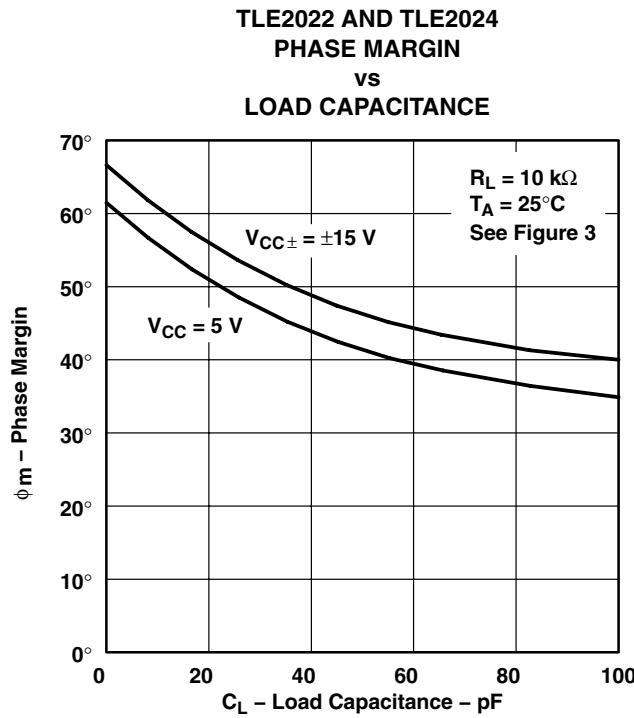


Figure 68

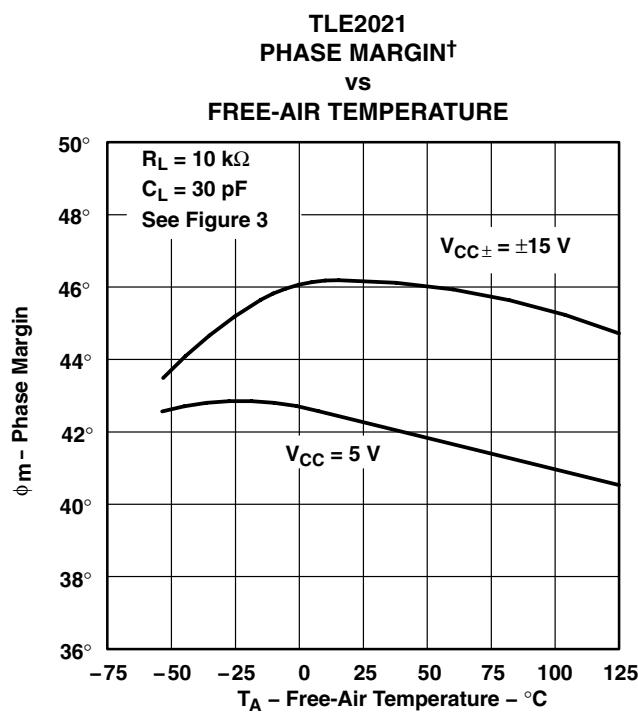


Figure 69

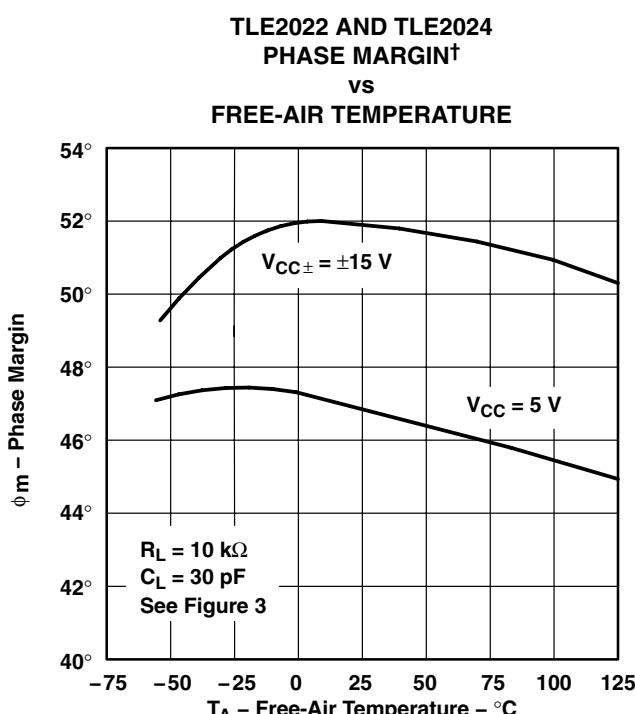


Figure 70

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

APPLICATION INFORMATION

voltage-follower applications

The TLE202x circuitry includes input-protection diodes to limit the voltage across the input transistors; however, no provision is made in the circuit to limit the current if these diodes are forward biased. This condition can occur when the device is operated in the voltage-follower configuration and driven with a fast, large-signal pulse. It is recommended that a feedback resistor be used to limit the current to a maximum of 1 mA to prevent degradation of the device. This feedback resistor forms a pole with the input capacitance of the device. For feedback resistor values greater than 10 k Ω , this pole degrades the amplifier phase margin. This problem can be alleviated by adding a capacitor (20 pF to 50 pF) in parallel with the feedback resistor (see Figure 71).

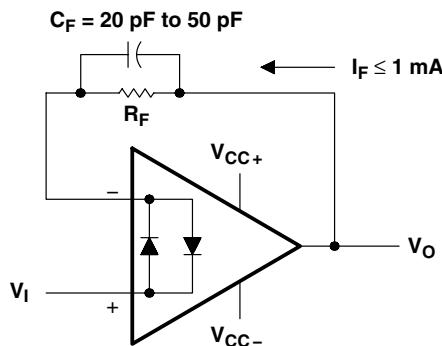


Figure 71. Voltage Follower

Input offset voltage nulling

The TLE202x series offers external null pins that further reduce the input offset voltage. The circuit in Figure 72 can be connected as shown if this feature is desired. When external nulling is not needed, the null pins may be left disconnected.

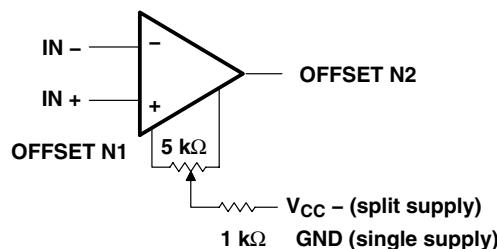


Figure 72. Input Offset Voltage Null Circuit

TLE202x-Q1, TLE202xA-Q1 EXCALIBUR HIGH-SPEED LOW-POWER PRECISION OPERATIONAL AMPLIFIERS

SGLS199B – JANUARY 2004 – REVISED APRIL 2008

APPLICATION INFORMATION

macromodel information

Macromodel information provided was derived using Microsim *Parts*™, the model generation software used with Microsim *PSpice*™. The Boyle macromodel (see Note 5) and subcircuit in Figure 73, Figure 74, and Figure 75 were generated using the TLE202x typical electrical and operating characteristics at 25°C. Using this information, output simulations of the following key parameters can be generated to a tolerance of 20% (in most cases):

- Maximum positive output voltage swing
- Maximum negative output voltage swing
- Slew rate
- Quiescent power dissipation
- Input bias current
- Open-loop voltage amplification
- Unity-gain frequency
- Common-mode rejection ratio
- Phase margin
- DC output resistance
- AC output resistance
- Short-circuit output current limit

NOTE 5: G. R. Boyle, B. M. Cohn, D. O. Pederson, and J. E. Solomon, "Macromodeling of Integrated Circuit Operational Amplifiers", *IEEE Journal of Solid-State Circuits*, SC-9, 353 (1974).

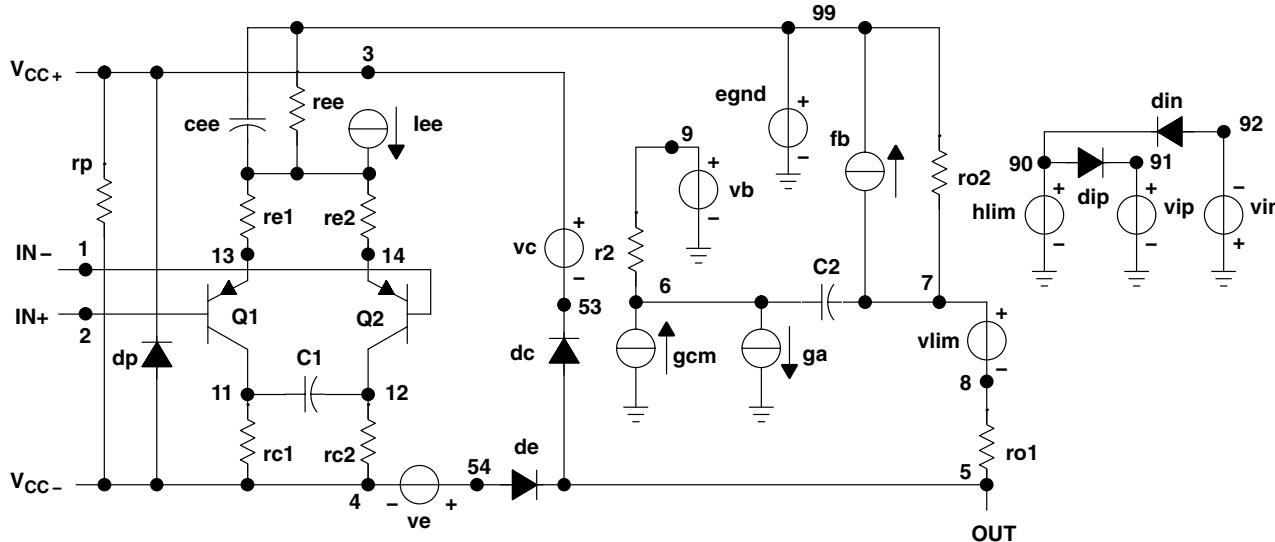


Figure 73. Boyle Subcircuit

PSpice and *Parts* are trademarks of MicroSim Corporation.

TLE202x-Q1, TLE202xA-Q1
**EXCALIBUR HIGH-SPEED LOW-POWER PRECISION
 OPERATIONAL AMPLIFIERS**

SGLS199B – JANUARY 2004 – REVISED APRIL 2008

```
.SUBCKT TLE2021 1 2 3 4 5
*
c1 11 12 6.244E-12
c2 6 7 13.4E-12
c3 87 0 10.64E-9
cpsr 85 86 15.9E-9
dcm+ 81 82 dx
dcm- 83 81 dx
dc 5 53 dx
de 54 5 dx
dlp 90 91 dx
dln 92 90 dx
dp 4 3 dx
ecmr 84 99 (2 99) 1
egnd 99 0 poly(2) (3,0) (4,0) 0 .5 .5
epsr 85 0 poly(1) (3,4) -60E-6 2.0E-6
ense 89 2 poly(1) (88,0) 120E-6 1
fb 7 99 poly(6) vb vc ve vlp vln vpsr 0 547.3E6
+ -50E7 50E7 50E7 -50E7 547E6
ga 6 0 11 12 188.5E-6
gcm 0 6 10 99 335.2E-12
gpsr 85 86 (85,86) 100E-6
grc1 4 11 (4,11) 1.885E-4
grc2 4 12 (4,12) 1.885E-4
gre1 13 10 (13,10) 6.82E-4
gre2 14 10 (14,10) 6.82E-4
hlim 90 0 vlim 1k
```

```
hcmr 80 1 poly(2) vcm+ vcm- 0 1E2 1E2
irp 3 4 185E-6
iee 3 10 dc 15.67E-6
iio 2 0 2E-9
i1 88 0 1E-21
q1 11 89 13 qx
q2 12 80 14 qx
R2 6 9 100.0E3
rcm 84 81 1K
ree 10 99 14.76E6
rn1 87 0 2.55E8
rn2 87 88 11.67E3
ro1 8 5 62
ro2 7 99 63
vcm+ 82 99 13.3
vcm- 83 99 -14.6
vb 9 0 dc 0
vc 3 53 dc 1.300
ve 54 4 dc 1.500
vlim 7 8 dc 0
vlp 91 0 dc 3.600
vln 0 92 dc 3.600
vpsr 0 86 dc 0
.model dx d(is=800.0E-18)
.model qx pnp(is=800.0E-18 bf=270)
.ends
```

Figure 74. Boyle Macromodel for the TLE2021

```
.SUBCKT TLE2022 1 2 3 4 5
*
c1 11 12 6.814E-12
c2 6 7 20.00E-12
dc 5 53 dx
de 54 5 dx
dlp 90 91 dx
dln 92 90 dx
dp 4 3 dx
egnd 99 0 poly(2) (3,0) (4,0) 0 .5 .5
fb 7 99 poly(5) vb vc ve vlp vln 0
+ 45.47E6 -50E6 50E6 50E6 -50E6
ga 6 0 11 12 377.9E-6
gcm 0 6 10 99 7.84E-10
iee 3 10 DC 18.07E-6
hlim 90 0 vlim 1k
q1 11 2 13 qx
q2 12 1 14 qx
r2 6 9 100.0E3
```

```
rc1 4 11 2.842E3
rc2 4 12 2.842E3
gel 13 10 (10,13) 31.299E-3
ge2 14 10 (10,14) 31.299E-3
ree 10 99 11.07E6
rol 8 5 250
ro2 7 99 250
rp 3 4 137.2E3
vb 9 0 dc 0
vc 3 53 dc 1.300
ve 54 4 dc 1.500
vlim 7 8 dc 0
vlp 91 0 dc 3
vln 0 92 dc 3
.model dx d(is=800.0E-18)
.model qx pnp(is=800.0E-18 bf=257.1)
.ends
```

Figure 75. Boyle Macromodel for the TLE2022

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TLE2021AQDRG4Q1	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLE2021AQDRQ1	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLE2021QDRG4Q1	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLE2021QDRQ1	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLE2022AQDRG4Q1	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLE2022AQDRQ1	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLE2022QDRG4Q1	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLE2022QDRQ1	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLE2024AQDWWRG4Q1	ACTIVE	SOIC	DW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLE2024AQDWWRQ1	ACTIVE	SOIC	DW	16	2000	TBD	Call TI	Call TI
TLE2024QDWWRG4Q1	ACTIVE	SOIC	DW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLE2024QDWWRQ1	ACTIVE	SOIC	DW	16	2000	TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI

to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF TLE2021-Q1, TLE2021A-Q1, TLE2022-Q1, TLE2022A-Q1, TLE2024-Q1, TLE2024A-Q1 :

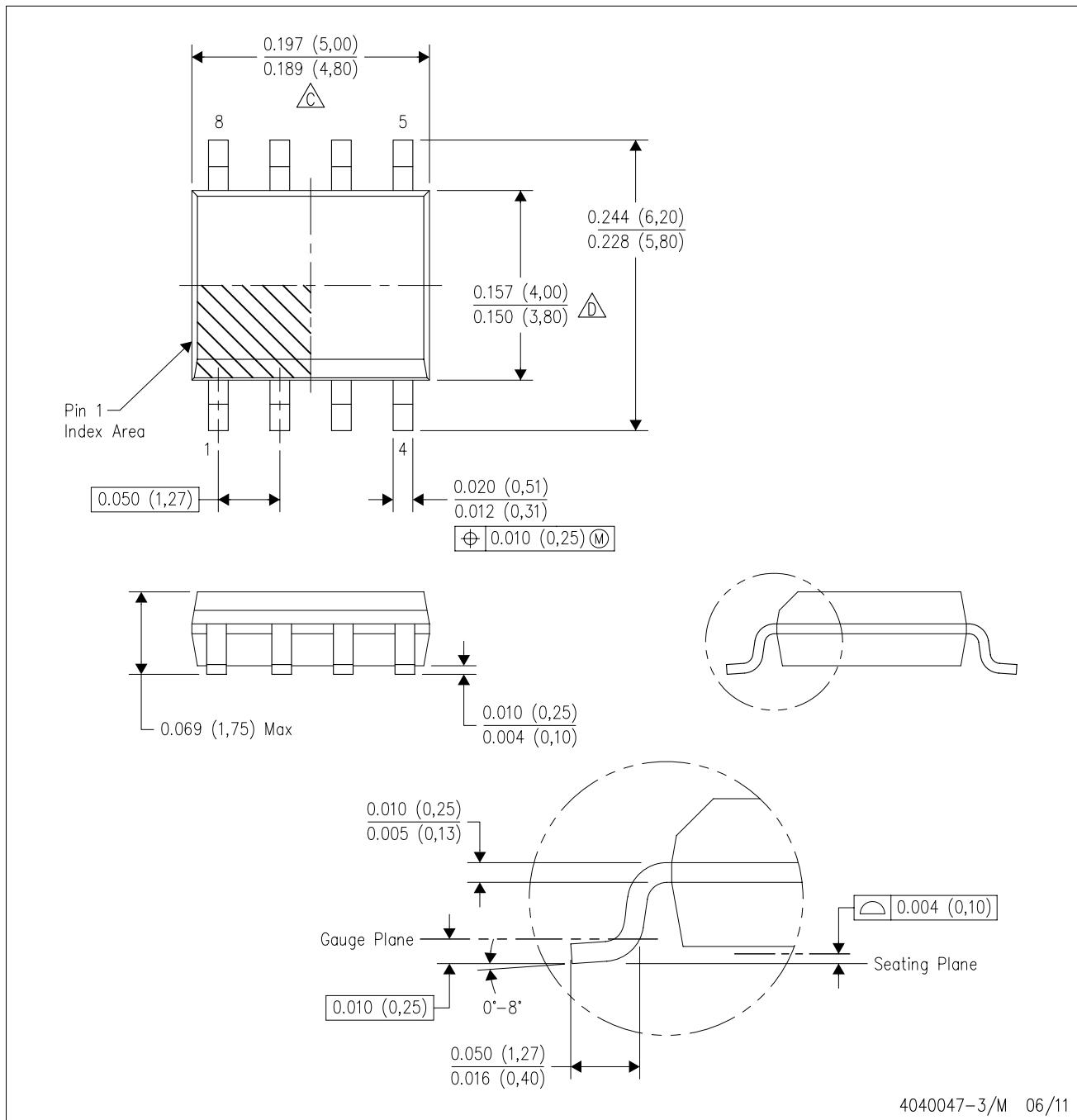
- Catalog: [TLE2021](#), [TLE2021A](#), [TLE2022](#), [TLE2022A](#), [TLE2024](#), [TLE2024A](#)
- Enhanced Product: [TLE2021-EP](#), [TLE2021A-EP](#), [TLE2022-EP](#), [TLE2022A-EP](#), [TLE2024-EP](#), [TLE2024A-EP](#)
- Military: [TLE2021M](#), [TLE2021AM](#), [TLE2022M](#), [TLE2022AM](#), [TLE2024M](#), [TLE2024AM](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Enhanced Product - Supports Defense, Aerospace and Medical Applications
- Military - QML certified for Military and Defense Applications

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

△C Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0.15) each side.

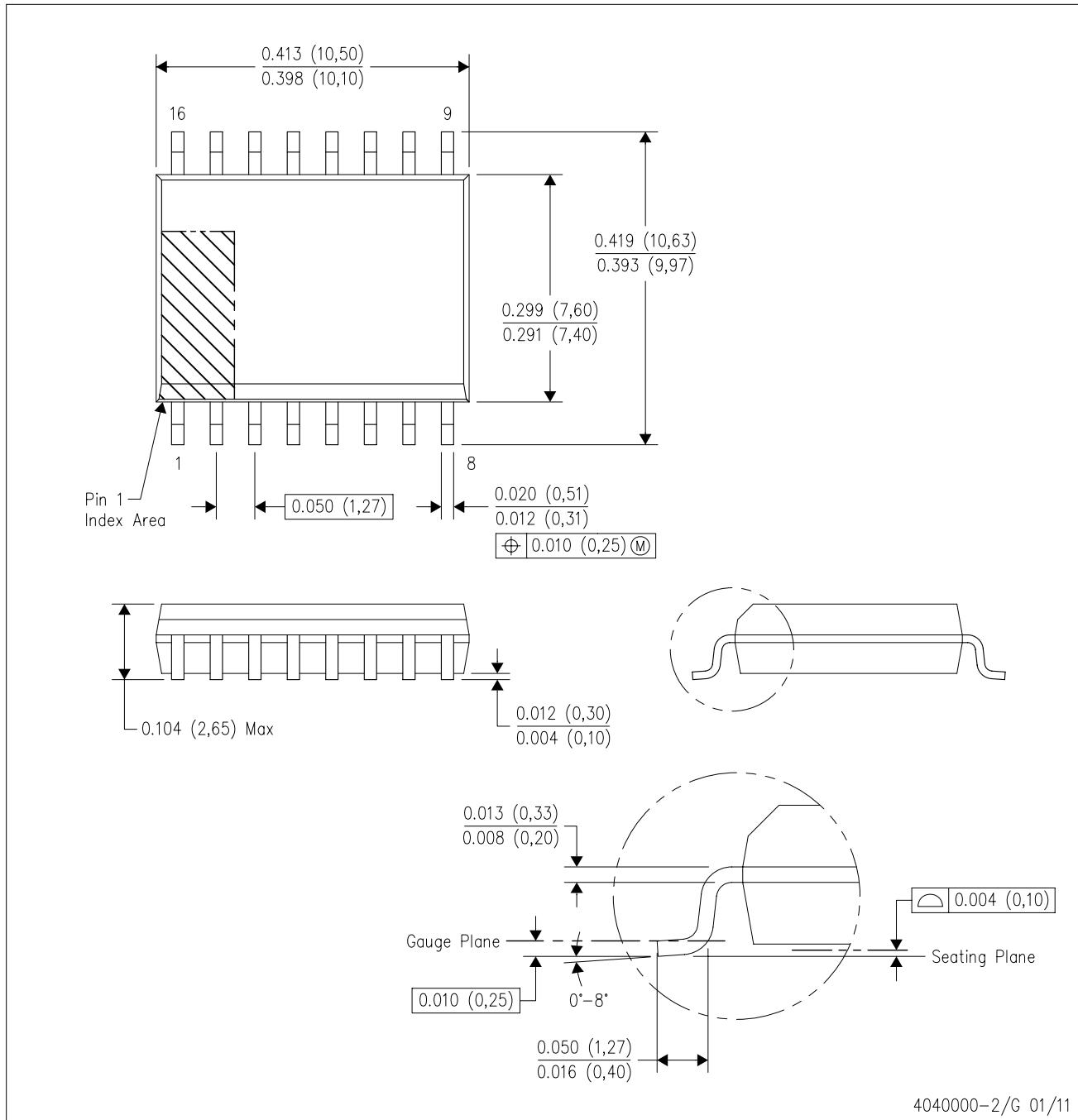
△D Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0.43) each side.

E. Reference JEDEC MS-012 variation AA.

MECHANICAL DATA

DW (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- NOTES:
- All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0.15).
 - Falls within JEDEC MS-013 variation AA.

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products

Audio	www.ti.com/audio
Amplifiers	amplifier.ti.com
Data Converters	dataconverter.ti.com
DLP® Products	www.dlp.com
DSP	dsp.ti.com
Clocks and Timers	www.ti.com/clocks
Interface	interface.ti.com
Logic	logic.ti.com
Power Mgmt	power.ti.com
Microcontrollers	microcontroller.ti.com
RFID	www.ti-rfid.com
RF/IF and ZigBee® Solutions	www.ti.com/lprf

Applications

Communications and Telecom	www.ti.com/communications
Computers and Peripherals	www.ti.com/computers
Consumer Electronics	www.ti.com/consumer-apps
Energy and Lighting	www.ti.com/energy
Industrial	www.ti.com/industrial
Medical	www.ti.com/medical
Security	www.ti.com/security
Space, Avionics and Defense	www.ti.com/space-avionics-defense
Transportation and Automotive	www.ti.com/automotive
Video and Imaging	www.ti.com/video
Wireless	www.ti.com/wireless-apps

[TI E2E Community Home Page](#)

[e2e.ti.com](#)

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2011, Texas Instruments Incorporated